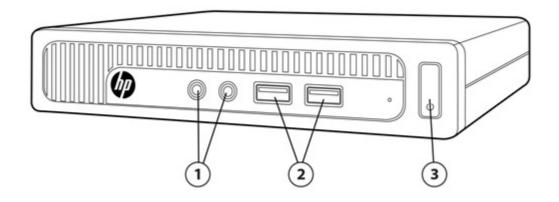
Overview

HP EliteDesk 800 G1 Desktop Mini Business PC



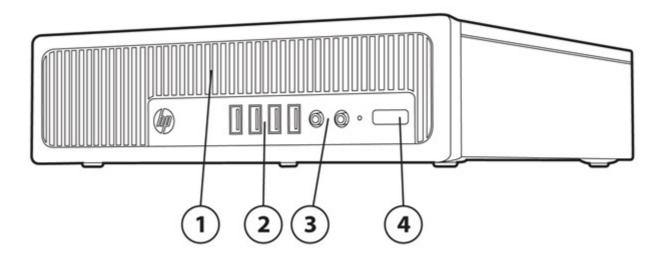
- 1. 3.5mm headphone output and microphone jacks
- 2. (2) Front USB 3.0 ports (1 USB Fast charging port)
- 3. Power button and PC status LED

Slots	(1) internal M.2 connector for optional wireless NIC (1) internal M.2 connector for optional SSD drive (Available Jun '14)
Bays	(1) 2.5" internal storage drive bay
Rear I/O	(4) USB 3.0 ports (1) VGA video port; (2) DisplayPort with multi-stream video ports (1) RJ-45 network connector 3.5mm audio out jack
VESA	Support for VESA 100 mounting system on bottom of PC chassis



Overview

HP EliteDesk 800 G1 Ultra-slim Desktop Business PC



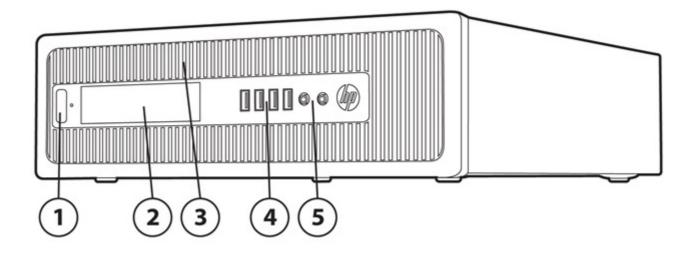
- 1. Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 2. (2) USB 3.0 ports, (2) USB 2.0 ports
- 3. 3.5mm headphone output and microphone jacks
- 4. Power button and PC status LED

Slots	(1) internal mSATA connector (1) internal PCI Express mini-card connector (1) MXM graphics connector
Bays	(1) 2.5" internal storage drive bay
Rear I/O	(2) USB 3.0 ports; (4) USB 2.0 ports (1) VGA video port; (2) DisplayPort with multi-stream video ports (1) RJ-45 network connector 3.5mm audio in/out jacks PS/2 keyboard and mouse ports
VESA	Support for VESA 100 mounting system on top and bottom of PC chassis



Overview

HP EliteDesk 800 G1 Small Form Factor Business PC

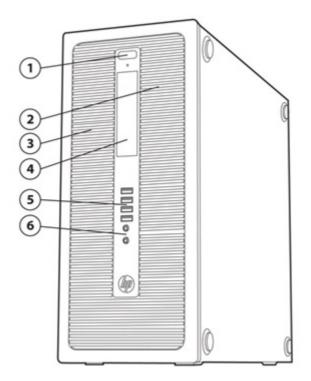


- 1. Power button and PC status LED
- 2. 3.5" external drive bay; used for installing a Media Card Reader or 2nd data storage drive
- 3. Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 4. (2) USB 3.0 ports, (2) USB 2.0 ports
- 5. 3.5mm headphone output and microphone jack

Slots	(2) PCI Express x16 graphics connectors; one wired as a x4 (2) PCI Express x1 accessory connectors
Bays	(1) 2.5" internal storage drive bay (1) 3.5" internal storage drive bay
Rear I/O	 (2) USB 3.0 ports; (4) USB 2.0 ports (1) VGA video port; (2) DisplayPort with multi-stream video ports (1) RJ-45 network connector (1) RS-232 serial port 3.5mm audio in/out jacks PS/2 keyboard and mouse ports



Overview



HP EliteDesk 800 G1 Tower Business PC

- 1. Power button and PC status LED
- 2. Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 3. 5.25" half height external drive bay (located behind removable bezel)
- 4. 3.5" external drive bay; used for installing a Media Card Reader
- 5. (2) USB 3.0 ports, (2) USB 2.0 ports
- 6. 3.5mm headphone output and microphone jack

Slots	 (2) PCI Express x16 graphics connectors; one wired as a x4 (2) PCI Express x1 accessory connectors (1) PCI accessory connector (optional)
Bays	(1) 2.5" internal storage drive bay (2) 3.5" internal storage drive bays
Rear I/O	(2) USB 3.0 ports; (4) USB 2.0 ports (1) VGA video port; (2) DisplayPort with multi-stream video ports (1) RJ-45 network connector



Overview

(1) RS-232 serial port3.5mm audio in/out jacksPS/2 keyboard and mouse ports



HP EliteDesk 800 G1 Series Business Desktop

QuickSpecs

Overview

At A Glance

- Choice of four chassis form factors: Desktop Mini, Ultra-slim Desktop, Small Form Factor and Tower
- PC chassis and all internal components and modules are manufactured with low halogen content
- HP developed and engineered UEFI BIOS supporting security, manageability and software image stability
- Intel[®] Q87 chipset supporting Intel 4th generation Core processors, featuring integrated Intel HD Graphics and Intel[®] vProTM Technology (available with select processors)
- Intel® Ethernet Connection I217L GbE LOM integrated network connection
- DDR3 Synchronous Dynamic Random Access Memory (SDRAM)
- Multi-independent monitor support via VGA and dual digital DisplayPort video interfaces with multi-stream
- DTS Studio Sound audio management software
- Standard and high efficiency energy saving power supply options
- SFF and TWR models can be configured with multiple data drives in a RAID array
- Optional Intel Smart Response Technology disk cache modules
- ENERGY STAR[®] qualified and certified EPEAT[®] Gold models
- Guaranteed lengthy purchase lifecycles and image stability



Standard Features and Configurable Components (availability may vary by country)

OPERATING SYSTEMS

Preinstalled

Windows 8.1 Pro (64-bit)* Windows 8.1 (64-bit)* Windows 7 Ultimate (32-bit)** Windows 7 Ultimate (64-bit)** Windows 7 Professional (32-bit)** Windows 7 Professional (64-bit)** Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8.1 Pro)*** Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8.1 Pro)*** Windows 7 Home Premium (32-bit)**

FreeDOS 2.0 Novell SUSE Linux Enterprise Desktop 11

*Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality. See http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

***This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 8 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

CHIPSET

Intel® Q87 Express	<u>DM</u> X	<u>USDT</u> X	<u>SFF/TWR</u> X
PROCESSOR			
Intel® 4th Generation Core™ i7 Processors	DM	USDT	<u>SFF/TWR</u>
Intel® Core™ i7-4765T Processor Up to 3.0 GHz Max. Turbo Frequency (2.0 GHz base frequency) 8 MB cache, 4 cores, 8 threads	x		
Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vProTM Technology and Intel® Stable Image Platform Program (SIPP)			



ndard Features and Configurable Components (availability may vary by country)		
Intel [®] Core [™] i7-4770 Processor Up to 3.9 GHz Max. Turbo Frequency (3.4 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel [®] vPro [™] Technology and Intel [®] Stable Image Platform Program (SIPP)		х
Intel® Core™ i7-4770S Processor Up to 3.9 GHz Max. Turbo Frequency (3.1 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)	х	
Intel Core i7-4771 Processor Up to 3.9 GHz Max. Turbo Frequency (3.5 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vProTM Technology and Intel® Stable Image Platform Program (SIPP)		Х
Intel® 4th Generation Core™ i5 Processors		
Intel® Core™ i5-4570 Processor Up to 3.6 GHz Max. Turbo Frequency (3.2 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)		X
<u>Intel® Core™ i5-4570S Processor</u> Up to 3.6 GHz Max. Turbo Frequency (2.9 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)	Х	
Intel® Core™ i5-4570T ProcessorXUp to 3.6 GHz Max. Turbo Frequency (2.9 GHz base frequency)4 MB cache, 2 cores, 4 threadsIntel HD Graphics 4600Supports DDR3 memory up to 1600 MT/s data rate		
Supports Intel® vProTM Technology and Intel® Stable Image Platform Program (SIPP)		



Intel® Core™ i5-4670 Processor		
Up to 3.8 GHz Max. Turbo Frequency (3.4 GHz base frequency)		
6 MB cache, 4 cores, 4 threads		
Intel HD Graphics 4600		
Supports DDR3 memory up to 1600 MT/s data rate		
Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)		
Intel® Core™ i5-4670S Processor	x	
Up to 3.8 GHz Max. Turbo Frequency (3.1 GHz base frequency)		
6 MB cache, 4 cores, 4 threads		
Intel HD Graphics 4600		
Supports DDR3 memory up to 1600 MT/s data rate		
Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)		
Intel® 4th Generation Core™ i3 Processors		
Intel® Core™ i3-4130 Processor	х	
Up to 3.4 GHz base frequency		
3 MB cache, 2 cores, 4 threads		
Intel HD Graphics 4400		
Supports DDR3 memory up to 1600 MT/s data rate		
Intel® Core™ i3-4330 Processor	Х	
Up to 3.5 GHz base frequency		
4 MB cache, 2 cores, 4 threads		
Intel HD Graphics 4600		
Supports DDR3 memory up to 1600 MT/s data rate		
Intel® Core™ i3-4340 Processor	х	
Up to 3.6 GHz base frequency		
4 MB cache, 2 cores, 4 threads		
Intel HD Graphics 4600		
Supports DDR3 memory up to 1600 MT/s data rate		
Intel® Core™ i3-4130T Processor	х	
Up to 2.9 GHz base frequency		
3 MB cache, 2 cores, 4 threads		
Intel HD Graphics 4400		
Supports DDR3 ,memory up to 1600 MT/s Data Rate		
Intel [®] Core™ i3-4330T Processor	х	
Up to 3.0 GHz base frequency		
op to 5.0 diaz base inequency		
4 MB cache, 2 cores, 4 threads Intel HD Graphics 4600		

Intel[®] 4th Generation Pentium[™] Processors



andard Features and Configurable Components (availability may vary by cou	ntry)		
Intel Pentium G3220T Up to 2.6 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate	X		
Intel® Pentium G3220 Processor Up to 3.0 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate		x	x
Intel® Pentium G3420 Processor Up to 3.2 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate		х	x
Intel® Pentium™ G3420T Processor 2.7 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate	х		
Intel® Pentium G3430 Processor Up to 3.3 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate		X	х
Intel® 4th Generation Celeron™ Processors Intel Celeron G1820T Processor Up to 2.4 GHz base frequency 2 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate	х		



Standard Features and Configurable Components (availability may vary by country)

GRAPHICS

	DM	USDT	SFF/TWR
Intel HD Graphics on all models (integrated on processor)	X	X	X
Optional Discrete Graphics Solutions			
AMD Radeon HD 7650A (MXM)		X	
NOTE: When this MXM graphics card is installed in the USDT all three monitor ports are active. The discrete ATI graphics will operate the top DisplayPort while the Intel integrated graphics will operate the bottom Multi-Stream DisplayPort and the VGA output.			
AMD Radeon HD 8350 (1GB) PCIe x16			X
AMD Radeon HD 8490 (1GB) PCIe x 16			X
NVIDIA NVS 310 (512 MB) PCIe x16			X
NVIDIA NVS 315 (1GB) PCIe x 16			X
NVIDIA GeForce GT630 (2 GB) FH PCIe x16			TWR only
Adapters and Cables	DM	USDT	SFF/TWR
HP DMS-59 to Dual DisplayPort Cable			X
HP DMS-59 to Dual DVI Cable			X
HP DMS-59 to Dual VGA Cable			X
HP DisplayPort to DisplayPort Cable	Х	Х	X
HP DisplayPort to DVI-D Adapter	Х	Х	X
HP DisplayPort to HDMI Adapter	Х	Х	Х
HP DisplayPort to VGA Adapter	Х	х	Х
HP Serial Port Adapter			Х
HP Parallel Port Adapter			X



Standard Features and Configurable Components (availability may vary by country)

STORAGE

	DM	USDT	SFF/TWR
Hard Disk Drives (HDD)		Х	
320 GB 7200 rpm HDD	X	Х	X
500 GB 7200 rpm HDD	X	Х	X
500 GB 7200 rpm SED HDD			X
500 GB 10K rpm HDD			X
1 TB 7200 rpm HDD			X
1 TB 10K rpm HDD			X
2 TB 7200 rpm HDD			х
Solid State Hybrid Drives (SSHD)	DM	<u>USDT</u>	SFF/TWR
500 GB SSHD (8 GB cache)	Х	Х	X
1 TB SSHD (8 GB cache)	X	X	х
Solid State Drives (SSD) & Self-encrypting Solid State Drives (SED)	DM	USDT	SFF/TWR
120 GB Opal SED	X	Х	X
128 GB SSD		Х	X
128 GB Opal SED	Х	Х	X
160 GB SSD		Х	X
180 GB Opal SED	Х	Х	X
256 GB SED		Х	X
128 GB M.2 PCle SSD (available June '14)	Х		
256 GB Opal SED	X	X	x
Optical Disc Drive	DM	USDT	<u>SFF/TWR</u>
Slim DVD-ROM		Х	X
Slim BDXL Blu-ray Writer		Х	X
Slim SuperMulti DVD Writer		Х	X
HH Supermulti ODD			TWR only
Removable			
HP Slim Removable SATA HDD Frame/Carrier		Х	X



MEMORY

Form Factor	Туре	Maximum	# of Slots
Desktop Mini	DDR3 non-ECC Up to 1600 MT/s	16 GB	2 SODIMM
Ultra Slim Desktop	DDR3 non-ECC Up to 1600 MT/s	16 GB	2 SODIMM
Small Form Factor	DDR3 non-ECC Up to 1600 MT/s	32 GB	4 DIMM
Tower	DDR3 non-ECC Up to 1600 MT/s	32 GB	4 DIMM

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Memory modules support data transfer rates up to 1600 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

PERFORMANCE

Intel [®] Smart Response Technology Disk Cache Modules	DM	USDT	SFF/TWR
2.5" Solid State Disk Cache			X
mSATA Solid State Disk Cache		Х	
NETWORKING/COMMUNICATIONS			
Ethernet (RJ-45)	DM	USDT	SFF/TWR
Intel I217LM Gigabit Network Connection (standard)	Х	х	X
Intel Ethernet I210-T1 PCIe x1 Gb Network Interface Card (optional)			X
Wireless			
Intel Centrino Advanced-N 6205 802.11 a/b/g/n PCI Express x1 Wireless Network Connection (optional)			X
Intel Centrino Advanced-N 6205 802.11 a/b/g/n PCI Express Mini Card Wireless Network Connection (optional)		х	
Intel Wireless-N 7260 802.11 M.2 a/b/g/n NIC Card Wireless Network Connection	х		
Intel Wireless-N 7260 802.11 a/b/g/n Mini PCIe NIC Card (USDT Only) Wireless Network Connection (optional)		х	
Intel Wireless-N 7260 802.11 a/b/g/n PCle- Clink Card (SFF/TWR Only) Wireless Network Connection (optional)			X
NOTE: Either the integrated network connection or the Intel Centrino wireless NIC is required to supp features.	ort Inte	l vPro Tec	hnology



AUDIO/MULTIMEDIA

	DM	USDT	SFF/TWR
HD audio with Realtek ALC221 codec (all ports are stereo)	Х	х	X
DTS Studio Sound audio management technology	х	х	X
Microphone* and headphone front ports (3.5mm)	х	х	X
Line-out and Line-In rear Ports* (3.5mm)	Line out	х	x
	only		
Multi-streaming capable*	Х	Х	X
Internal speaker (standard)	x	Х	Х

* The front microphone port is re-taskable as a Line-in, Microphone-in or Headphone-out port. Rear audio input ports are retaskable as a Line-in or Microphone-in port. External speakers must be powered externally. Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks. This allows for different audio applications to use separate audio ports on the system. For example, the front jacks could be used with a headset for a communications application while the rear jacks are being used with external speakers and a multimedia application.

KEYBOARDS AND POINTING DEVICES

Keyboard	DM	USDT	SFF/TWR
HP PS/2 Keyboard	Х	х	Х
HP USB Keyboard	Х	х	Х
USB Smart Card (CCID) Keyboard	Х	х	Х
HP USB and PS/2 Washable Keyboard	Х	х	Х
HP Wireless Keyboard and Mouse Combo* *Keyboard contains 25% post-consumer recycled plastic material	x	X	х
Mice	DM	USDT	<u>SFF/TWR</u>

HP PS/2 Mouse	Х	Х	Х
HP USB Mouse	х	Х	Х
HP USB 1000dpi Laser Mouse	Х	X	X
HP USB and PS/2 Washable Mouse	X	X	X



HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP EliteDesk 800 G1 Business PC into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Select models feature either Intel Standard Manageability or Intel Core vPro Processor Technology.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification 2.1
- Absolute Persistence agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so
 component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in
 any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (DOSFlash), BIOS updates from within Windows (HPQFlash), HP Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration
 management, allowing operating systems and applications to manage power based on activity and usage. HP Elite models
 use ACPI to provide power conservation features.
- S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W is S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.



Standard Features and Configurable Components (availability may vary by country)

SECURITY

	USDT/DM	SFF/TWR
Trusted Platform Module (TPM) 1.2	Х	X
SATA port disablement (via BIOS)	Х	X
Drive lock	X	X
RAID configurations		X
Intel Identify Protection Technology (IPT) ¹	X	X
Serial, parallel, USB enable/disable (via BIOS)	X	X
Optional USB Port Disable at factory (user configurable via BIOS)	X	X
Removable media write/boot control	X	X
Power-On password (via BIOS)	X	X
Setup password (via BIOS)	X	X
HP Chassis (1 bay) Security Kit		TWR only
Solenoid Hood Lock / Sensor	USDT	X
	only	
Support for chassis padlocks and cable lock devices	х	х

¹Models configured with Intel Core processors have the ability to utilize advanced security protection for online transactions. IPT, used in conjunction with participating web sites, provides double identity authentication by adding a hardware component in addition to the usual user name and password. IPT is initialized through an HP Client Security module.

ENVIRONMENTAL & REGULATORY

ENERGY STAR[®] qualified models available EPEAT[®] registered where applicable/supported. See <u>www.epeat.net</u> for registration status by country. Low halogen (chassis, all internal components and modules) TAA compliant

PORTS

I/O Ports – Standard

	DM	USDT	SFF/TWR
USB 2.0	N/A	2 (front); 4 (rear)	2 (front); 4 (rear)
USB 3.0	2 (front); 4 (rear)	2 (front); 2 (rear)	2 (front); 2 (rear)
Serial (RS-232)	N/A	N/A	1
PS/2		1 keyboard (purple) 1 mouse (green)	1 keyboard (purple) 1 mouse (green)
Video	1 ea. VGA 2 ea. DisplayPort with multi- stream	1 VGA 2 DisplayPort with multi-stream	1 VGA 2 DisplayPort with multi-stream

NOTE: When configured with an Intel Celeron, Pentium or 4th generation Intel Core i3 CPU only two of the available video output ports are active



Standard Features and Configurable Components (availability may vary by country)

Audio	Front: headphone/mic Rear: line in/out 3.5mm diameter	Front: headpl Rear: line in/o 3.5mm diame	out Rear: li	headphone/mic ine in/out 1 diameter
Network Interface	RJ-45	RJ-45	RJ-45	
I/O Ports – Optional				
· · · · · ·	DM		USDT	SFF/TWR
2nd Serial (RS-232)	N/A		N/A	1
Parallel	N/A		N/A	1
SLOTS				
JLUIJ	DM	USDT	SFF	TWR
PCI Express Mini Card	N/A	1	<u>577</u> N/A	N/A
MXM Graphics	N/A	1	N/A	N/A N/A
mSATA	N/A	1	N/A	N/A
M.2	1 ea. M.2-2230 (for WLAN) 1 ea. M.2-2280 (for storage)	N/A	N/A	N/A
PCI Express x1 (v2.0)	N/A	N/A	2 ea. 2.5" low profile 6.6" length 10W max. power	2 ea. 4.2" full height 6.6" length 10W max. power
PCI Express x16 (v2.0) (wired as a x4)	N/A	N/A	1 ea. 2.5" low profile 6.6" length 35W max. power	1 ea. 4.2" full height 6.6" length 35W max. power
PCI Express x16 (v3.0)	N/A	N/A	1 ea. 2.5" low profile 6.6" length 35W max. power	1 ea. 4.2" full height 6.6" length 75W max. power
Optional PCI (v2.3)	N/A	N/A	N/A	1 ea. 4.2" full height 6.6" length

NOTE: The TWR can support a single graphics card up to 75W. When configured with dual graphics cards support is limited to 35W for each.



BAYS

	DM	USDT	SFF	TWR
3.5" Media Card Reader	N/A	N/A	1 ea.	1 ea.
5.25" Half Height ODD	N/A	N/A	N/A	1 ea.
Slim ODD	N/A	1 ea.	1 ea.	1 ea.
Secure Digital (SD) Reader	N/A	1 ea.	N/A	N/A
2.5" internal storage drive	1 ea.	1 ea.	1 ea.	1
3.5" internal storage drive	N/A	N/A	1 ea.	2 ea.

SERVICE AND SUPPORT

On-site Warranty ¹: Three-year (3-3-3) limited warranty delivers three years of on-site, next business day ² service for parts and labor and includes free telephone support ³ 24 x 7. Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing a Care Pack. To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/go/cpc

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured and third-party HP qualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.



Technical Specifications – Operating Systems, Software and eDocumentation

OPERATING SYSTEMS

Preinstalled

Windows 8.1 Pro (64-bit)* Windows 8.1 (64-bit)* Windows 7 Ultimate (32-bit)** Windows 7 Ultimate (64-bit)** Windows 7 Professional (32-bit)** Windows 7 Professional (64-bit)** Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8.1 Pro)*** Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8.1 Pro)*** Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8.1 Pro)*** Windows 7 Home Premium (32-bit)** Windows 7 Home Premium (64-bit)** FreeDOS 2.0 Novell SUSE Linux Enterprise Desktop 11

For all Preinstalled operating systems HP provides Microsoft WHQL certified (where applicable) drivers on www.hp.com at the time of product announcement.

Web Support

Windows 7 Enterprise (32-bit or 64-bit) Windows 8 (64-bit) Windows 8 Pro (64-bit)* Windows 8 Enterprise (64-bit)**

For all Supported operating systems HP performs testing of the OS, and makes available all HP value add software (OS dependent). Certified drivers are made available on www.hp.com within 30 days of product announcement.

Certified

Novell SUSE Linux Enterprise Desktop 11¹

For all Certified operating systems HP will submit hardware to the operating system vendor for testing and certification. All drivers would be obtained from the operating system vendor, not supplied by HP. Certification will be posted by the operating system vendor.

Test & Document

Windows[®] Vista Enterprise (32-bit or 64-bit) Windows[®] Vista Professional (32-bit or 64-bit)

For all Test & Document operating systems HP will perform functional testing of the operating system on the HP business PC platform. Any issues found will be documented in an Engineering Advisory and/or Service Advisory and posted to www.hp.com. HP will not develop or qualify any drivers or perform any integration testing.

*Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality. See http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

***This system is preinstalled with Windows[®] 7 Pro software and also comes with a license and media for Windows 8 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

¹The following features are not supported by Novell SUSE Linux Enterprise Desktop:

- Intel Gigabit CT Desktop NIC
- Broadcom NetXtreme Gigabit Ethernet Plus



Technical Specifications – Operating Systems, Software and eDocumentation

- HP Media Card Reader
- HP Client Security
- HP Blu-ray Writer playback of commercial movies
- DisplayPort video interface
- HP 2nd serial port adapter
- Power Management features

Systems configured with Linux do not qualify for ENERGY STAR®

The following features are not supported by Red Hat Enterprise Linux 64:

- TPM v1.2 embedded Security Chip
- Intel Gigabit CT Desktop NIC
- HP Wireless 802.11b/g/n NIC
- HP Media Card Reader
- HP Blu-ray Writer
- HP 2nd serial port Adapter
- HP USB Smart Card (CCID) Keyboard
- Power Management features

Systems configured with Linux do not qualify for ENERGY STAR®

SOFTWARE

Included	Windows 7	Windows 8.1
Security	Absolute Persistence (status tracing) ¹ Device Access Manager Drive Encryption ⁴ File Sanitizer (Activated via Wizard) Disk Sanitizer (external version) ² Secure Erase HP Client Security	Computrace (status tracing) ¹ Device Access Manager Drive Encryption ⁴ File Sanitizer (Activated via Wizard) Disk Sanitizer (external version) ² Microsoft Defender Secure Erase HP Client Security
MultiMedia	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)
Communication		HP Wireless Hotspot
HP Value Add	HP ePrint Driver ³ HP PageLift HP Support Assistant HP Recovery Disk Creator	HP ePrint Driver ³ HP PageLift HP Recovery Manager HP Support Assistant HP QuickStart
3 rd Party	Adobe Flash Player Bing Search for Internet Explorer 10 Box PDF Complete, Corporate Edition Skype	Bing Search PDF Complete, Corporate Edition Skype



Technical Specifications – Operating Systems, Software and eDocumentation

Microsoft Buy Office Products

Buy Office

¹ Computrace agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging from one to five years. Service is limited, check with Absolute for availability outside the U.S.

² Available via download

³ Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary

4 Drive Encryption is planned to be available in October 2013. Requires Windows. Data is protected prior to Drive Encryption login. Turning the PC off or into hibernate logs out of Drive Encryption and prevents data access.



Technical Specifications – Core vPro Processors

INTEL 4th GENERATION CORE vPRO PROCESSORS

All HP EliteDesk 800 G1 Business PC models featuring this technology include processors that are part of the Intel 2013 Stable Image Platform Program (SIPP) designed to ensure the stability promise inherent in the value proposition of the HP EliteDesk 800 G1 Business PC, thus making these models the most stable, secure, and manageable platforms available to enterprises today.

Intel Advanced Management Technology (AMT) v9.0 – An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 9.0 includes the following advanced management functions:

- Power Management (on, off, reset)
- Hardware Inventory (includes BIOS and firmware revisions
- Hardware Alerting
- Agent Presence
- System Defense Filters
- SOL/IDER
- Cisco NAC/SDN Support
- ME Wake-on-LAN
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the PC connects to the IT or service provider console for maintenance. Remote PCs can get required patches, be inventoried, etc by connecting to their IT console or Service Provider when it's convenient.
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration
- Management Engine (ME) firmware roll back
- Wireless AMT functionality on Desktop (WoDT)
- Enhanced KVM resolution



Intel HD Graphics

VGA Controller	Integrated		
DisplayPort	Multimode capable; supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-Stream Technology for a maximum of 3 displays (including the integrated panel)		
Bus Type	N/A		
RAMDAC	N/A		
Memory	Intel graphics do not have dedicated memory but utilizes some of the computer's system memory The amount of memory used for graphics depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio Video Playback) support for playback of protected video content.		
	Additional memory is allocated for graphics as need (DVMT), to provide an optimal balance between grap		
Maximum Graphics	Microsoft Windows 7	Windows 8	
Memory	Up to 1.7GB	Up to 1.8GB	
	Note : the actual amount of maximum graphics mem depending upon your computer's configuration.	nory can be less than the amounts listed above	
Maximum Color Depth	32 bits/pixel		
Graphics/Video API Support	 4th Generation Core processors: The Processor Graphics contains a refresh of substantial gains in performance and lower p 		
	 Next Generation Intel Clear Video Technology enhancement features that improve the end u Encode/transcode HD content Playback of high definition content incl Superior image quality with sharper, m DirectX Video Acceleration (DXVA) support for Full AVC/VC1/MPEG2 HW Decode Advanced Scheduler 2.0, 1.0 Windows 7, Windows 8, Linux OS Support DirectX 11.1 OpenGL 4.0 	HD Support is a collection of video playback and user's viewing experience luding Blu-ray Disc lore colorful images	
	• Open CL 1.2		
NOTE: other recelu	Supported Display Resolutions and Re		
NUIE: Other resolu	tions may be available but are not recommended as the	ey may not have been tested and qualined by HP	

Resolution	Refresh Rates
800x600	60 Hz
1024x768	60 Hz
1152x864	60 Hz
1280x600	60 Hz
1280x720	60 Hz
1280x800	60 Hz
1280x960	60 Hz
1280x1024	60 Hz
1360x768	60 Hz
1366x768	60 Hz
1400x1050	60 Hz
1440x900	60 Hz
1600x900	60 Hz
1600x1200*	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz
1920x1200*	60 Hz
1920x1440*	60 Hz
2560x1440*	60 Hz
2560x1600*	60 Hz
3840x2160*	60 Hz

* Only supported on displays connected to the external DisplayPort connector.

AMD Radeon HD 7650A Graphics Card

Form Factor	MXM 3.0
Graphics Controller	AMD Radeon HD 7650A
Core Clock	600MHz
Memory Clock	800MHz
Memory	2GB, DDR3, 128-bit wide
Bus Type	МХМ
Max. Power	35W
Power Source Support	12V and 19V
3D API Support	DX11, SMS
HDCP Support	Yes
Display Max. Resolution	Digital 2560 x 1600 Analog 2048 x 1536
Supported Graphics APIs	DX11, OpenGL, full 1080p BD (H264) playback in hardware, Multi-Stream DisplayPort support



Supported Display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

Resolution	Refresh Rates
800x600	60 Hz
1024x768	60 Hz
1280x720	60 Hz
1280x1024	60 Hz
1360 x 768	60 Hz
1440x900	60 Hz
1600 x 900	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz

NVIDIA NVS 310 Graphics Card

Introduction	The NVIDIA® NVS™ 310 Graphics Card is a PCI Express low profile form factor graphics add-in card targeted as an active low cost graphics solution for the corporate business and enterprise markets. The NVIDIA® NVS 310 graphics card is an ideal solution for customers requiring a small form factor graphics add-in card for either standard or small form factor PC designs.
Performance and Features	The NVIDIA® NVS 310 Graphics Card offers 512 MB of ultrafast DDR3 memory and is capable of supporting up to 2 displays.
	DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.
	For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.
Form Factor (H x L)	Low Profile: 2.713 × 6.15 in
Graphics Controller	NVIDIA [®] NVS 310
Memory Clock	875MHz
Memory Size	512 MB DDR3
Memory Bandwidth	14 GB/s
Max. Power	19.5W
Display Max. Resolution	Up to 2560 x 1600 (digital display) per display
Display Output	Up to 2 displays in the following configurations
	DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card
- Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort Multi-Stream topology technology



DVI-D output:

	using DisplayPort • Drives two digital	to DVI-D single-link cable	o 2560× 1600 at 60 Hz with	-
	•	e of driving two high defini ing DisplayPort to HDMI ca	tion (HD) panels up to resol ble adaptors	utions of 1920 ×
	 Drives two analog cable adaptors 	display at resolutions up t	:o 1920 × 1200 at 60 Hz usiı	ng DisplayPort to VGA
Max. Power	19.5 W			
Display Resolutions and Refres Note: other resolutions may be a		nmended as they may not	have been tested and qualif	fied by HP
Resolution		Maximum Refresh Rat	es (Hz) by Connection	
	DisplayPort to VGA	DisplayPort to DVI-D	DisplayPort to HDMI	DisplayPort

	DisplayPort to VGA	DisplayPort to DVI-D	DisplayPort to HDMI	DisplayPort
640 x 480	85	60	60	60
800 x 600	85	60	60	60
1024 x 768	85	60	60	60
1280 x 720	85	60	60	60
1280 x 1024	85	60	60	60
1440 x 900	75	60	60	60
1600 x 1200	60	60	60	60
1680 x 1050	60	60	60	60
1920 x 1080	60-R	60-R	60	60
1920 x 1200	60-R	60-R		60
1920 x 1440				60
2048 x 1536				60
2560 x 1600				60
0 P dopotos roducod l	blanking timings are used on	cingle link DVI connection	s and may be used with oth	or digital connection

Note: 60-R denotes reduced blanking timings are used on single link DVI connections and may be used with other digital connections.



NVIDIA GeForce GT630 Graphics Card

Introduction	The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Card Graphics Card provides a full height, PCI Express x16 graphics add-in card solution based on the NVIDIA Kepler Architecture GPU. The card is designed to support three display connections through its DVII, and two DisplayPort connectors.
	An ideal solution for desktop PC customers seeking enhanced 2D and advanced 3D graphics performance, the NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards are an excellent choice for business users who want run multiple displays from a single graphics board. Engage in Web conferencing or video or photo editing, while improving your everyday business PC experience with better graphics and excellent visual display quality.
Performance and Features	The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards deliver superior PCI Express (PCIe) Gen 3 features including:
	 Unprecedented flexibility for new applications and enhanced performance Support for NVIDIA surround technology Run multiple displays from a single graphics card Full 16 lane PCIe Generation 3 bus support with peak bandwidth support Wireless Display ready for future support
Form Factor	PCIe x16 Card
Graphics Controller	NVIDIA Kepler Architecture GPU
Core Clock	875 MHz
Memory Clock	891 MHz
Memory Size	2 GB DDR3 128 bit
Memory Bandwidth	28.5 GB/s
Display Max. Resolution	2560 x 1600 digital, 2048 x 1536 analog
Display Support	Integrated 400 MHz RAMDAC

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution		Maximum Refresh Rates (Hz)
	Analog Connection	Digital Connection
640x480	85	60
800×600	85	60
1024x768	85	60
1280x720	85	60
1280x1024	85	60
1440x900	75	60
1600x1200	85	60
1680x1050	75	60
1920x1080	85	60-R
1920x1200	85	60-R
1920x1440	85	60
2048x1536	75	60
2560x1600	N/A	60



NVIDIA NVS 315 1GB PCIe x 16 Graphics Card

Introduction	Get efficient dual-display graphics performance in a F NVS 315 PCIe x16 1 GB Graphics Card, an ideal deskto commercial applications.	
Performance and Features	The NVIDIA® NVS 315 Graphics Card offers 1 GB of ult to 2 displays.	rafast DDR3 memory and is capable of supporting up
	DisplayPort connector supports multimode technolog monitors with optional adapters in kits NR078AA, FH9	
	For a DisplayPort to DisplayPort connections use the	optional DisplayPort Cable Kit VN567AA.
Form Factor	Low Profile: 2.713 × 6.15 in	
Graphics Controller	NVIDIA [®] NVS 315	
Memory Clock	875MHz	
Memory Size	512 MB DDR3	
Memory Bandwidth	14 GB/s	
Connectors	DMS-59 , with support for dual VGA, dual DVI or dual I	Display Port with the appropriate adapter cable
Display Max. Resolution	Up to 2048 x 1536 VGA; 1920 x 1200 DVI; 2560 x 160	0 DisplayPort
Display Output	Up to 2 displays in the following configurations	
	 Dual DisplayPort : Drives two DisplayPort using optional HI Dual VGA : Drives two analog using the included HP Supported Display Resolutions and Reitions and R	DMS-59 to Dual VGA Cable
NOTE: Other resolut		
	ions may be available but are not recommended as the	may not have been tested and qualified by HP.
NOTE: Other resolut Resolution	ions may be available but are not recommended as the Maximum Refresh Rat	may not have been tested and qualified by HP. tes (Hz) by Connection
	ions may be available but are not recommended as the	may not have been tested and qualified by HP.
Resolution	ions may be available but are not recommended as the Maximum Refresh Rat Analog Connection	may not have been tested and qualified by HP. tes (Hz) by Connection Digital Connection
Resolution 640x480	tions may be available but are not recommended as the Maximum Refresh Rat Analog Connection 85	may not have been tested and qualified by HP. tes (Hz) by Connection Digital Connection 60
Resolution 640x480 720x480	tions may be available but are not recommended as the Maximum Refresh Rat Analog Connection 85 85	may not have been tested and qualified by HP. tes (Hz) by Connection Digital Connection 60 60
Resolution 640x480 720x480 720x576	tions may be available but are not recommended as the Maximum Refresh Rat Analog Connection 85 85 85	may not have been tested and qualified by HP. tes (Hz) by Connection Digital Connection 60 60 60
Resolution 640×480 720×480 720×576 800×600	tions may be available but are not recommended as the Maximum Refresh Rat Analog Connection 85 85 85 85	may not have been tested and qualified by HP. tes (Hz) by Connection Digital Connection 60 60 60 60 60
Resolution 640x480 720x480 720x576 800x600 1024x768	tions may be available but are not recommended as the Maximum Refresh Rat Analog Connection 85 85 85 85 85 85	may not have been tested and qualified by HP. tes (Hz) by Connection Digital Connection 60 60 60 60 60 60 60
Resolution 640x480 720x480 720x576 800x600 1024x768 1280x720	tions may be available but are not recommended as the Maximum Refresh Rat Analog Connection 85 85 85 85 85 85 85	may not have been tested and qualified by HP. tes (Hz) by Connection Digital Connection 60 60 60 60 60 60 60 60 60
Resolution 640x480 720x480 720x576 800x600 1024x768 1280x720 1280x768	tions may be available but are not recommended as the Maximum Refresh Rat Analog Connection 85 85 85 85 85 85 85 85	may not have been tested and qualified by HP. tes (Hz) by Connection Digital Connection 60 60 60 60 60 60 60 60 60 60
Resolution 640x480 720x480 720x576 800x600 1024x768 1280x720 1280x768 1280x1024	tions may be available but are not recommended as the Maximum Refresh Rate Analog Connection 85 85 85 85 85 85 85 85 85	may not have been tested and qualified by HP. tes (Hz) by Connection Digital Connection 60 60 60 60 60 60 60 60 60 60
Resolution 640x480 720x480 720x576 800x600 1024x768 1280x720 1280x768 1280x1024 1440x900	tions may be available but are not recommended as the Maximum Refresh Rat Analog Connection 85 85 85 85 85 85 85 85 85 85 75	may not have been tested and qualified by HP. tes (Hz) by Connection Digital Connection 60 60 60 60 60 60 60 60 60 60
Resolution 640x480 720x480 720x576 800x600 1024x768 1280x720 1280x768 1280x7024 1440x900 1600x1024	tions may be available but are not recommended as the Maximum Refresh Rate Analog Connection 85 85 85 85 85 85 85 85 85 85 85 85 85	may not have been tested and qualified by HP. tes (Hz) by Connection Digital Connection 60 60 60 60 60 60 60 60 60 60
Resolution 640x480 720x480 720x576 800x600 1024x768 1280x720 1280x720 1280x768 1280x1024 1440x900 1600x1024 1600x1200	tions may be available but are not recommended as the Maximum Refresh Rat Analog Connection 85 85 85 85 85 85 85 85 85 85 85 85 85	may not have been tested and qualified by HP. tes (Hz) by Connection Digital Connection 60 60 60 60 60 60 60 60 60 60



Technical Specifications - Graphics

1920x1440	85	N/A
2048x1536	75	N/A
2560x1440	N/A	60*
2560x1600	N/A	60*
		* Display Port Only

AMD Radeon HD 8350 1GB PCie x16 DH Graphics Card

Introduction	Get stable 2D and advanced 3D graphics performance from the AMD Radeon HD 8350 1 GB PCIe x16 DH Graphics Card, a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon HD 8350 GPU, great for Web conferencing or video and photo editing.
Form Factor	PCie x16
Graphics Controller	AMD Radeon HD 8350
Core Clock	GPU engine operates at 523 MHz
Memory	1GB, DDR3, SDRAM
Memory Clock	875 MHz
HDCP Support	Yes
Display Max. Resolution	Digital 1920 x 1200
	Analog 2048 x 1536

Supported Display Resolutions and Refresh Rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

	Analog Connection	Digital Connection
640x480	85	60
720x480	85	60
720x576	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x768	85	60
1280x1024	85	60
1440x900	75	75
1600x1024	85	60
1600x1200	85	60
1680x1050	75	75-R
1920x1080	85	60-R
1920x1200	85	60-R
1920x1440	85	N/A
2048x1536	75	N/A
2560x1440	N/A	N/A
2560x1600	N/A	N/A



AMD Radeon HD 8490 1GB PCie x16 Graphics Card

Get impressive graphics and high resolution dual-display performance in a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon HD 8490 Graphics Processor. Improve your everyday PC, Web conferencing, and video or photo editing.
PCie x16
AMD Radeon HD 8490
GPU engine operates at 875 MHz
1GB, DDR3, SDRAM
900 MHz
Yes
Digital 2560 x 1600 Analog 2048 x 1536

Supported Display Resolutions and Refresh Rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

	Analog Connection	Digital Connection
300 x 200	85	60
320 x 240	85	60
400 x 300	85	60
640x480	85	60
720x480	85	60
720x576	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x768	85	60
1280x1024	85	60
1440x900	75	75
1600 x 900	85	60
1600x1024	85	60
1600x1200	85	60
1680x1050	75	75-R
1920x1080	85	60-R
1920x1200	85	60-R
1920x1440	85	N/A
2048x1536	75	N/A
2560x1440	N/A	60
2560x1600	N/A	60



Introduction:

HP Serial Advanced Technology Attachment (SATA) Hard Drives maximize the performance of HP Business PCs by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance.

SATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, the SATA interface connects hard drives to the PC platform enabling easy aggregation of multiple hard drives into a single PC. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability. The HP EliteDesk 800 G1 Series Business PC supports the latest SATA 6.0Gb/s specification.

HP Drive Lock

HP Serial ATA Hard Drives offer enhanced security via a new Drive Lock. When enabled, this ATA security feature set prevents software access to user data on the drive until one or two user-defined passwords are provided.

SMART IV Technology

Self-Monitoring Analysis and Reporting Technology (SMART) hard drive technology allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

Native Command Queuing

NCQ or Native Command Queuing is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), which allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver. AHCI support is typically implemented in RAID configurations.

Note: GB = 1 billion bytes. Actual available capacity is less.



Redundant Array of Independent Drives (RAID)

Flexible implementation:

- DriveLock is supported while in RAID mode. Users can manage the DriveLock password from within F10 Setup. Locked drives will be displayed as such in the RAID option ROM interface.
- Hard drive information can be viewed within F10 Setup while in RAID mode. Previously, the hard drives will not appear in Drive Configuration when switching to RAID mode.
- DPS Self-Test can be executed on physical hard drives while in RAID mode.
- The RAID Setup Utility (accessed through CTRL-I) can be protected by the F10 Setup password.

NOTE:

RAID 1 is the only RAID configuration offered via factory configurations. The pre-configured systems:

- Are only available on the SFF and TWR form factors. The USDT and DM form factors do not support RAID as they do not allow for multiple common storage drives.
- Are complete RAID systems and have both drives installed. If the TWR is configured with three hard disk drives, the third drive is would be un-partitioned and not part of the RAID array
- Have the necessary Option ROM configuration.
- Are pre-loaded and pre-installed with all required Intel software.
- Include a preinstalled operating system that is mirrored mode out of the box.

HP 1TB 10K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

•		
Capacity	1 TB	
Rotational Speed	10,000 rpm	
Interface	Serial ATA (6.0 Gb/s)	
Synchronous Transfer Rate (Maximum)	Up to 600 MB/s	
Buffer Size	64 MB	
Cache	Adaptive	
Seek Time (typical reads,	Single Track:	1.2 ms
includes controller overhead,	Average:	3.6 ms
including settling)	Full-Stroke:	9.0 ms
Height (nominal)	0.6 in/1.53 mm	
Width (nominal)	Media diameter: 2.5 in/63.6 mm	
width (noninat)	Physical size: 2.75 in/69.9 mm	
Operating Temperature	41° to 131° F (5° to 55° C)	



HP 500 GB 10K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity	500 GB	
Rotational Speed	10,000 rpm	
Interface	Serial ATA (6.0 Gb/s)	
Synchronous Transfer Rate (Maximum)	Up to 600 MB/s	
Buffer Size	64 MB	
Cache	Adaptive	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track: Average: Full-Stroke:	1.2 ms 3.6 ms 9.0 ms
Height (nominal)	0.6 in/1.53 mm	
Width (nominal)	Media diameter: 2.5 in/63.6 mm Physical size: 2.75 in/69.9 mm	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 320-GB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive

Capacity	320,072,933,376 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 2.0 (6.0 Gb/s)	
Buffer Size	16 MB	
Logical Blocks	488,397,168	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track:	2.0 ms
	Average:	11 ms
	Full-Stroke:	22 ms
Height (nominal)	0.374 in/9.5 mm	
Width (nominal)	Media diameter: 2.5 in/63.5 mm	
	Physical size: 2.75 in/70 mm	
Operating Temperature	41° to 131° F (5° to 55° C)	



HP 500-GB 7200 RPM SATA 2.5" Self-Encrypting (SED) Hard Disk Drive

Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Drive Type	Self-Encrypting Drive (SED) with SATA interface	
Interface	SATA Interface conforming to Serial ATA International Organization: Serial ATA Revision 2.6	
Segmented Buffer with write cache	32768 KB - A portion of buffer capacity used for firmware	
Number of Sectors	976,773,168	
Seek Time (typical reads,	Single Track:	1.0 ms
includes controller overhead,	Average:	13 ms
including settling)	Full-Stroke:	25 ms
Media Diameter	2.5 in/63.5 mm	
Height	0.267 in/6.8 mm, ±0.2mm	
Width	2.75 in/69.85 mm, ±0.25mm	
Length	3.945 in/100.2 mm, ±0.25mm	
Weight	3.35 oz/95 g (max)	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 500-GB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive

Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 2.0 (6.0 Gb/s)	
Buffer Size	16 MB	
Logical Blocks	976,773,168	
Seek Time (typical reads,	Single Track:	2.0 ms
includes controller overhead, including settling)	Average:	11 ms
	Full-Stroke:	25 ms
Height (nominal)	0.374 in/9.5 mm	
Width (nominal)	Media diameter: 2.5 in/63.5 mm	
	Physical size: 2.75 in/70 mm	
Operating Temperature	41° to 131° F (5° to 55° C)	



Technical Specifications – Hard Disk and Solid State Storage

HP 1-TB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

1 TD		
I IB		
5,400 rpm +/- 0.2%		
Solid State Hybrid Drive (SSHD) technology with NAND Flash		
Serial ATA (SATA)		
64 MB		
8 GB		
976,773,168		
Single Track:	2.0 ms	
Average:	12 ms	
0.374 +/008 in (9.5 +/- 0.2 mm)		
2.750 +/- 0.010 in (69.85 +/- 0.25 mm)		
3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)		
0.254 lb/115 g (max)		
32° to 140° F (0° to 60° C)		
	Solid State Hybrid Drive (S Serial ATA (SATA) 64 MB 8 GB 976,773,168 Single Track: Average: 0.374 +/008 in (9.5 +/- 0. 2.750 +/- 0.010 in (69.85 + 3.951 +0.008 / -0.010 in (1 0.254 lb/115 g (max)	

HP 500 GB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity	500 GB	
Spindle Speed	5,400 rpm +/- 0.2%	
Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash	
Interface	Serial ATA (SATA)	
Cache Buffer	64 MB	
NAND Flash	8 GB	
Commercial Multilevel Cell (cMLC)		
Number of Sectors	976,773,168	
Seek Time (typical reads)	Single Track:	2.0 ms
	Average:	12 ms
Height	0.268 +/008 in (6.8 +/- 0.2 mm)	
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)	
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)	
Weight	0.209 lb/95 g (max)	
Operating Temperature	32° to 140° F (0° to 60° C)	



Technical Specifications – Hard Disk and Solid State Storage

HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 3.0 (6.0 Gb/s)	
Buffer Size	16 MB	
Logical Blocks	976,773,168	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track: 2.0 ms Average: 11 ms Full-Stroke: 21 ms	
Height (nominal)	1 in/2.54 cm	
Width (nominal)	Media diameter: 3.5 in/8.89 cm Physical size: 4 in/10.2 cm 41° to 131° F (5° to 55° C)	
Operating Temperature		

HP 120-GB Solid State Drive

Unformatted Capacity	120 GB		
Architecture	Multi Level Cell (MLC) NAND Flash with wear leveling 10 channel controller		
Interface	Serial ATA 2.0 (3.0 Gb/s)		
Dimensions (W x H x D)	2.74 x 0.37 x 4 in/6.98 x 0.95 x 10.2 cm		
Weight	0.18 lb/80 g		
	Sustained Sequential Read:	Up to 250 MB/s	
Bandwidth Performance	Sustained Sequential Write:	Up to 70 MB/s	
	Random Read:	Up to 35K IOPs	
	Random Write:	Up to 6.6K IOPs	
Latency	Read:	65-ms	
	Write:	85-ms	
Power	DC power requirement:	5 VDC 5%-100 mV ripple p-p	
l owci	Total power consumption:	0.15W (active); 0.075W (idle)	
Useful Drive Life	35TB written, up to 20GB/day for 5 years		
	Operating Temperature:	32° to 158° F (0° to 70° C)	
Environmental (all conditions, non-condensing)	Relative Humidity:	5% to 95%	
	Maximum Wet Bulb Temperature (operating):	84° F (29° C)	
	Shock:	1,500 G/0.5-ms	
and the second second second	A LINE A CONCENT OF	a second to a second the second	

* For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

** The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.



Technical Specifications – Hard Disk and Solid State Storage

HP 128 GB Solid State Drive

Unformatted Capacity	128 GB*	
Architecture	Multi Level Cell (MLC) NAND	
Interface	SATA 6 GB/sec	
Dimensions (W x H x D)	2.75 x 0.276 x 3.96 in (6.985 x 0.	7 x 10.05 cm)
Weight	0.16 lb (73 g)	
	Sustained Sequential Read:	Up to 450 MB/s
Bandwidth Performance	Sustained Sequential Write:	Up to 260 MB/s
Danuwiuch Periormance	Random Read:	up to 46K IOPs
	Random Write:	up to 56K IOPs
Latency	Read:	55ms (TYP)
Lucency	Write:	55ms (TYP)
Power	DC power requirement:	Min 4.5 V; Max 5.5 V
	Total power consumption:	160 mW (Active) ; <85 mW; (Idle)
Useful Drive Life	1.2 million device hours**	
	Operating Temperature:	32° to 158° F (0° to 70° C)
Environmental	Relative Humidity:	5% to 95%
(all conditions, non-condensing)	Maximum Wet Bulb Temperature (operating):	84° F (29° C)
	Shock:	1,500 G/1.0 msec
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea KCC, CE Mark	
Option kit contents	HP 128 GB Solid State Drive, documentation, 3.5-inch bay adapter bracket, 3.5-inch bay adapter bracket screws, SATA cable	

* For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

** The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.



Technical Specifications – Hard Disk and Solid State Storage

HP 160 GB Solid State Drive

Unformatted Capacity	160 GB*	
Architecture	Multi Level Cell (MLC) NAND	
Interface	SATA 3 GB/sec	
Dimensions (W × H × D)	2.74 x 0.37 x 4 in (6.98 x 0.95 x 1	0.2 cm)
Weight	0.18 lb (80 g)	
	Sustained Sequential Read:	Up to 250 MB/s
Bandwidth Performance	Sustained Sequential Write:	Up to 70 MB/s
Danuwiuch Perior mance	Random Read (4KB):	up to 35K IOPs
	Random Write (4KB):	up to 6.6K IOPs
Latency	Read:	65 ms
Latency	Write:	85 ms
Power	DC power requirement:	5 VDC 5%-100 mV ripple p-p
i owei	Total power consumption:	0.15 Watt (Active); 0.075 Watt (Idle)
Useful Drive Life	35TB written, up to 20GB/day for 5 years **	
Environmental	Operating Temperature:	32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:	5% to 95%
	Shock:	1,500 G/1.0 msec
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea KCC, CE Mark	

* For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content ** The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

HP 256 GB SATA 2.5" Self-Encrypting (SED) Solid State Drive

Unformatted Capacity	256,186,209,271 bytes	
Architecture	Self-Encrypting (SED) Solid State Drive with 25nm MLC NAND Flash and SATA interface	
Interface	Serial ATA 2.0 (3.0 Gb/s)	
NAND Flash	25nm MLC NAND Flash	
Height	.275 in/7mm	
Width	2.75 in/69.85 mm	
Length	3.95 in/100.5 mm	
Weight	0.161 lb (73 g)	
	Sustained Sequential 128k Read:	Up to 450 MB/s
Bandwidth Performance	Sustained Sequential 128k Write:	Up to 260 MB/s
Danuwiuth Performance	Random 4k Read:	up to 46K IOPs
	Random 4k Write:	up to 56K IOPs
Latency	Read:	55 µs
	Write:	55 µs
Power	SATA power consumption:	160 mW (active average); <85 mW (idle average)



Technical Specifications – Hard Disk and Solid State Storage

Useful Drive Life	72TB written, up to 40GB/day for 5 years	
Fundational	Operating Temperature:	32° to 158° F (0° to 70° C)
Environmental (all conditions, non-condensing)	Relative Humidity:	5% to 95%
(all conditions, non condensing)	Shock:	1,500 G/1.0-ms

HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity	500,107,862,016 bytes
Rotational Speed	7,200 rpm
Interface	Serial ATA 3.0 (6.0 Gb/s)
Buffer Size	16 MB
Logical Blocks	976,773,168
Seek Time (typical reads, includes controller overhead, including settling)	Single Track: 2.0 ms Average: 11 ms Full-Stroke: 21 ms
Height (nominal)	1 in/2.54 cm
Width (nominal)	Media diameter: 3.5 in/8.89 cm Physical size: 4 in/10.2 cm
Operating Temperature	41° to 131° F (5° to 55° C)

HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity	1,000,204,886,016 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 3.0 (6.0 Gb/s)	
Buffer Size	32 MB	
Logical Blocks	1,953,525,168	
Seek Time (typical reads,	Single Track:	2.0 ms
includes controller overhead,	Average:	11 ms
including settling)	Full-Stroke:	21 ms
Height (nominal)	1 in/2.54 cm	
Width (nominal)	Media diameter: 3.5 in/8.89 cm	
	Physical size: 4 in/10.2 cm	
Operating Temperature	41° to 131° F (5° to 55° C)	



Technical Specifications – Hard Disk and Solid State Storage

HP 2-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity	2 TB	
Rotational Speed	7,200 rpm	
Interface	SATA 6Gb/s NCQ	
Buffer Size	64 MB	
Cache, Multisegmented (MB)	1,953,525,168	
Seek Time (average)	Read	<8.5 ms
Seek Time (average)	Write	<9.5 ms
Height	1.028 in/26.11 mm	
Width	4.0 in/101.6 mm	
Depth	5.787 in/146.99 mm	
Weight	1.38 lb/626 g	
Operating Temperature	32° to 140° F (0° to 60° C)	



Technical Specifications - Removable Storage

HP Slim SuperMulti DVD Writer Drive

Height	12.7mm height		
Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
Disc recording capacity	Up to 8.5 GB DL or 4.7 GB standa	rd	
Dimensions (W × H × D)	5.04 x 0.5 x 5.0 in (128 x 12.7 x ²	127 mm) without bezel	
Weight (max)	0.42 lb (190 g)		
	DVD-RAM	Up to 5X	
	DVD-R DL	Up to 6X	
	DVD+R	Up to 8X	
	DVD+RW	Up to 8X	
Write speeds	DVD+R DL	Up to 6X	
	DVD-R	Up to 8X	
	DVD-RW	Up to 6X	
	CD-R	Up to 24X	
	CD-RW	Up to 24X	
	DVD-RAM	Up to 5X	
	DVD-RW, DVD+RW	Up to 8X	
	DVD-R DL, DVD+R DL	Up to 8X	
Read speeds	DVD+R, DVD-R	Up to 8X	
	DVD-ROM DL, DVD-ROM	Up to 8X	
	CD-ROM, CD-R	Up to 24X	
	CD-RW	Up to 24X	
Access time	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)	
(typical reads, including settling)	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)	
Settling)	Stop Time	6 seconds (typical)	
	Source	Slimline SATA DC power receptacle	
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p	
	DC Current	5 VDC (< 1000 mA typical, 1600 mA maximum)	



Technical Specifications - Removable Storage

	Temperature	41° to 122° F (5° to 50° C)
Environmental conditions	Relative Humidity	10% to 80%
(operating - non-condensing)	Maximum Wet Bulb Temperature	84° F (29° C)

HP Slim Blu-ray BDXL Drive

Height	12.7mm Slim tray-load		
Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
Disc capacity		, 50 GB DL or 25 GB standard	SL
Dimensions	•	.7 x 127 mm) without bezel	
W x H x D (max)			
Weight (max)	Up to 0.37 lb (170 g) withou	ıt bezel	
		Triple-layer	Quadruple-layer
	BD-R	Up to 4x	Up to 4x
	BD-RE	Up to 2x	Not supported
		Single-layer	Double-layer
	BD-R	Up to 6x	Up to 6x
	BD-RE	Up to 2x	Up to 2x
	DVD-R	Up to 8x	Up to 6x
Write speeds	DVD-RW	Up to 6x	Not supported
	DVD+R	Up to 8x	Up to 6x
	DVD+RW	Up to 8x	Not supported
	DVD-RAM	Up to 5x	N/A
	CD-R	Up to 24x	N/A
	CD-RW	Up to 24x	N/A
		Triple-layer	Quadruple-layer
	BD-R	Up to 4x	Up to 4x
	BD-RE	Up to 4x	Not supported
		Single-layer	Double-layer
	BD-ROM	Up to 6X	Up to 6X
	BD-R	Up to 6x	Up to 6x
	BD-RE	Up to 6x	Up to 6x
	DVD-ROM	Up to 8x	Up to 8x
	DVD-R	Up to 8x	Up to 8x
Read speeds	DVD-RW	Up to 8x	Not supported
	DVD+R	Up to 8x	Up to 8X
	DVD+RW	Up to 8x	Not supported



Technical Specifications - Removable Storage

	BDMV (AACS Compliant Disc)	Up to 6x/2x (Read/Play)
	DVD-RAM	Up to 5x
	DVD-Video (CSS Compliant Disc)	Up to 8x/4x (Read/Play)
	CD-R/RW/ROM	Up to 24x
	CD-DA (DAE)	Up to 20x/10x (Read/Play)
Access times (typical reads, including	Random	BD-ROM: 205 ms (typical), DVD-ROM: 185 ms (typical), CD-ROM: 165 ms (typical)
setting)	Full Stroke	BD-ROM: 350 ms (typical), DVD-ROM: 345 ms (typical), CD-ROM: 340 ms (typical)
Power	Source	Slimline SATA DC power receptacle
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p
	DC Current	5 VDC -1200 mA typical, 2000 mA maximum
Environmental	Temperature (operating)	41° to 122° F (5° to 50° C)
(all conditions non-condensing)	Relative Humidity (operating)	10% to 80%
	Maximum Wet Bulb Temperature (operating)	84° F (29° C)

HP Slim DVD-ROM Drive

Height	12.7mm		
Orientation	Either horizontal or vertical	Either horizontal or vertical	
Interface type	SATA/ATAPI		
Dimensions (W \times H \times D)	5.04 x 0.5 x 5.0 in (128 x 12.7 x 1	127 mm) without bezel	
Weight (max)	Up to 0.37 lb (170 g) without bez	zel	
	DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X	
Read speeds	DVD-ROM	Up to 8X	
	CD-ROM, CD-R	Up to 24X	
	CD-RW	Up to 24X	
Access time	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)	
(typical reads, including settling)	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)	
	Source	Slimline SATA DC power receptacle	
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p	
	DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum	



Technical Specifications - Removable Storage

	Temperature	41° to 122° F (5° to 50° C)
Environmental (all conditions	Relative Humidity	10% to 80%
non-condensing)	Maximum Wet Bulb Temperature (operating)	84° F (29° C)



Technical Specifications – Memory

System Memory Support

The HP EliteDesk 800 G1 Business PC supports the 4th generation Intel[®] Core[™] processor family. Based on a new PC micro-architecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). Unlike previous generations, the 4th generation Intel[®] Core[™] processor includes an Integrated Memory Controller (IMC). The IMC supports DDR3/DDR3L protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC DDR3/DDR3L unbuffered dual in-line memory modules (UDIMM) or DDR3/DDR3L unbuffered small
 outline dual in-line memory modules (SO-DIMM) with a maximum of two DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 1600 MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR3/DDR3L system memory I/O voltage of 1.5V
- Theoretical maximum memory bandwidth of:
 - O 21.3 GB/s in dual-channel mode assuming 1333 MT/s
 - O 25.6 GB/s in dual-channel mode assuming 1600 MT/s

Platform Memory Support

- The Small Form Factor (SFF) and Tower (TWR) platforms support up to four (4) industry-standard DDR3-SDRAM DIMMs.
- The Ultra-slim Desktop (USDT) and Desktop Mini (DM) support up to two (2) industry-standard DDR3-SDRAM SO-DIMMs

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.



Technical Specifications - Networking and Communications

Intel® I217LM GbE Network Connection (integrated)

Connector	RJ-45
System Interface	Integrated on PCA
Controller	Intel I217LM GbE platform LAN connect networking controller
Memory	24 KB FIFO packet buffer memory
Data rates supported	10/100/1000 Mbps
IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3ab 802.3az 802.3az
Bus architecture	PCI Express and SMBus
Data transfer mode	PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)
Power requirement	Requires 3.3V and 0.9V or just 3.3V with integrated regulators Power consumption 0.733 Watts
Boot ROM support	Yes
Network transfer mode	Full-duplex
	Half-duplex (not supported for the 1000BASE-T transceiver)
Network transfer rate	10BASE-T (half-duplex) 10 Mbps
	10BASE-T (full-duplex) 20 Mbps
	100BASE-TX (half-duplex) 100 Mbps
	100BASE-TX (full-duplex) 200 Mbps
	1000BASE-T (full-duplex) 2000 Mbps
Environmental	Operating Temperature: 0° to 85° C
	Operating Humidity: 60% RH
Management	WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable diagnostic
Alerting	ASF 2.0 support; AMT 9.0 support

Technical Specifications - Networking and Communications

Intel® Ethernet I210-T1 Gigabit Network Adapter

Connector	RJ-45
System Interface	PCI Express x1
Controller	Intel® I210 Gigabit Ethernet Controller
Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers
Data rates supported	10/100/1000 Mbps
IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3AB 802.3u 802.3u 802.3x flow control
Bus architecture	PCI-E 2.1
Data path width	X1, 250 MB/s, Bi-directional interface
Data transfer mode	Bus-master DMA
Hardware certifications	FCC, B, CE, TUV-c, TUVus Mark Canada and United States, TUV-GS Mark for European Union
Power requirement	Aux 3.3 V, 3.0 Watts in 1000 base-T and 1.0 Watts in 100 Base-T
Boot ROM support	Yes
	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps
Network Transfer Rate	100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)
Environmental	Operating Temperature: 32° to 131°F (0° to 55° C) Operating Humidity: 85% at 131° F (55° C)
Management	WOL, PXE, DMI, WFM 2.0

Intel Centrino Advance-N 6205 Wireless Network Interface Connection

Wireless LAN Standards	IEEE 802.11a/b/g/n
	IEEE 802.11 e, 802.11i, 802.11d, 802.11d, 802.11h
Interoperability	Wi-Fi certified (802.11 a/b/g/n WMM, WPA, WPA2 and WPS)
	Tested with wireless access points from several major manufacturers
	OS compatible with Microsoft Windows, Win7 and XP
	Cisco Compatible Extensions Program compliant (802.11a/b/g only) with Microsoft Windows XP and Windows 7
Frequency Band	2.4 GHz and 5 GHz
Antenna Structure	2 transmit; 2 receive (2x2)



Technical Specifications - Networking and Communications

Data Rates 802.11b: 1, 2, 5, 5, 11 Mbps 802.11a: 65 possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n specification Modulation Direct Sequence Spread Spectrum BDPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAH Security Supports 64 - and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key sizes of 128bits), TKP, 802.11 x authentication types EAP-TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPV2, LEAP, EAP-TATS, EAP-SM, EAT, EAP-SM, EA-AKA PAP, CHAP, TLS, FEAP, MSCHAP, PEAP-MSCHAPV2, LEAP, EAP-TATS, EAP-SM, EAT, EAP-SM, EAP-AKA PAP, CHAP, TLS, FEAP, MSCHAP, PEAP-MSCHAPV2, LEAP, EAP-TATS, EAP-SM, EAT, EAP-SM, EAP-AKA PAP, CHAP, TLS, FEAP, MSCHAP, PEAP-MSCHAPV2, LEAP, EAP-TATS, EAP-SM, EAT, EAP-SM, EAP-AKA PAP, CHAP, TLS, FEAP, MSCHAP, PEAP-MSCHAPV2, LEAP, EAP-TATS, EAP-SM, EAT, EAP-SM, EAP-AKA PAP, CHAP, TLS, FEAP Sub-channels Multinational support with frequency bands and channels compliant to local regulations. Media Access Protocol CSMA/CA (Collision Avoidance) with ACK Network Architecture Modes Ad-hoc (Peer to Peer) Intrastructure cecess points (Same frequency band) Intrastructure (Access Point Required) Intref WM Wiff Technology (IPAN) Reaming Transmit: 2.3 Watts (average with two receive chains) Intervalues and formation of free environment and anoter: 1.90 Watts (average with two receive chains) Intervalues and formation of free environment and environment and envice coutdoor Open Area and envice compliant power saving	-	-		
B02.11n - 66 possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11 n specification Modulation Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16–QAM, 64–QAM Security Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key sizes of 128 bits), TKP, 802.1 x authentication types EAP-TLS, EAP-TLS, PEAP, MSCHAP, PEAP-MSCHAPV2, LEAP, EAP-FAST, EAP-SM, PAP, CAPA, CAP, CAP, CAP, CAP, CAP, CA	Data Rates			
Bandwidth, Modulation Coding Scheme, and Guard interval used, as defined in IEEE 802.11n specificationModulationDirect Sequence Spread Spectrum DBPSK, DQPSK, CG, OPDM, BPSK, OPSK, 16-QAM, 64-QAMSecuritySupports 6-and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key sizes of 128bits), TKP, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPv2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPv2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPv2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPv2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPV2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPV2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, EAP-TTLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPV2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, EAP-TTLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPV2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, EAP-TTLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPV2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, EAP-TTLS, EAP-TTLS, PEAP, MSCHAP, PEAP-THS, TLS, EAP-TTLS, EAP-TTLS, EAP-TTLS, EAP-AKAP, CHAP, TLS, EAP-TTLS, EAP-TTLS, EAP-TTLS, EAP-AKAP, CHAP, TLS, EAP-TTLS, EAP-TTLS, EAP-TTLS, EAP-TTLS, EAP-AKAP, CHAP, TLS, EAP-TTLS, EAP-TTLS, EAP-TTLS, EAP-TTLS, PEAP, MSCHAP, VEPAP, TLS, EAP-TTLS, EAP-				
BBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM Security Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key sizes of 128bits). TKP, 802.11 & authentication types EAP-TLS, EAP-TLS, PEAP-TMS, PEAP-MSCHAP22, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, GTC Sub-channels Multinational support with frequency bands and channet infrastructure products through the Cisco Compatibility with Cisco Aironet infrastructure products through the Cisco Compatibility with Cisco Aironet infrastructure products through the Cisco Compatibility exits and the Microsoft Windows XP only. Sub-channels Multinational support with frequency bands and channets compliant to local regulations. Media Access Protocol CSMA/CA (Collision Avoidance) with ACK Network Architecture Models Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) Intrel® My Wifi Technology (IPAN) Roaming CSMA/CA (Collision Avoidance) with ACK Output Power (for OFDM; 15 dBm power varies by data rate! Receive: 1.9 Watts (average, with one spatial streams) Power Consumption Receive: 1.9 Watts (average with two receive chains) Idle mode: 30mW - 40mW (average) Idle mode: 30mW - 40mW (average) Receive: 1.9 Watts (average with two receive chains) Idle mode: 30m Receive: 1.9 Watts (average with two receive chains) Fower Consumption 30J.FL type connectors, 50 ohm nominal impedance		Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n		
128bits), TKIP, 802.1x authentication types EAP-TLS, EAP-TLS, FEAP, MSCHAP, PEAP-MSCHAPv2, LEAP, EAP, FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, GTC Sub-channels Mutinational support with frequency bands and channels compliant to local regulations. Media Access Protocol CSMA/CA (Collision Avoidance) with ACK Network Architecture Modelia Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) Intel® My Wifi Technology (iPAN) Roaming Provide seamless roaming between like access points (same frequency band) Output Power (for OFDM; power varies by data rate) Formanie: 2.3 Watts (average, with one spatial streams) Receive: 1.9 Watts (average with two receive chains) Receive: 1.9 Watts (average with two receive chains) Idle mode: 300M – 400M (mary) Solon feet - Outdoor Open Area 150 feet - Indoor, Office environment 150 feet - Indoor, Office environment 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment 150 feet - Indoor, Office environment 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment 1200 feet - Outdoor Open Area 300 feet - Indoor	Modulation			
bub constant is a subset of the clisco Compatible Extensions Program Version 4) with Microsoft Windows XP only.Sub-channelsMultinational support with frequency bands and channels compliant to local regulations.Media Access ProtocolCSMA/CA (Collision Avoidance) with ACKNetwork Architecture ModelsCSMA/CA (Collision Avoidance) with ACKNetwork Architecture ModelsComparison of the clisco Compatible Extensions Program Version 4) with Microsoft Windows XP only.RoamingCSMA/CA (Collision Avoidance) with ACKPower ManagementSdBmOutput Power (for OFDM; power varies by data rate)Transmit: 2.3 Watts (average, with one spatial streams)Power ConsumptionTransmit: 2.3 Watts (average, with now receive chains)Radio off: 20 mW (max)Compliant power management 802.11 compliant power management 802.11 a - Typical (@6 Mbps)RangeBo2.11 a - Typical (@6 Mbps)600 feet - Outdoor Open Area 150 feet - Indoor, Office environment 150 feet - Indoor, Office environment 300 feet - Indoor, Office environmentForm FactorsUSDT (Min & SFF: (Min & SFF: (Dimensions))J200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentWeight0.31 k (A.0 g)J200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentMeight0.31 k (A.0 g)J200 feet - Outdoor Open Area 300 feet - Indo	Security	128bits), TKIP, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPv2,		
Media Access ProtocolCSMA/CA (Collision Avoidance) with ACKNetwork Architecture ModelsAd-hoc (Peer to Peer) Infrastructure (Access Point Required) Intel® Wiff Technology (iPAN)RoamingProvide seamless roaming between like access points (same frequency band)Output Power (for CCK)15 dBmOutput Power (for OFDM; power varies by data rate)15 dBmPower ConsumptionTransmit: 2.3 Watts (average, with one spatial streams) Receive: 1.9 Watts (average) idle mode: 30mW - 40mW (average) Radio off: 20 mW (max)Power Management802.11 compliant power anagement 802.11 compliant power saving modeAntenna Connections30.FL type connectors, 50 ohm nominal impedanceRange802.11 a - Typical (@6 Mbps)600 feet - Outdoor Open Area 150 feet - Indoor, Office environment 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment 300 feet - Indoor, Office environment 			•	
Network Architecture ModelsAd-hoc (Peer to Peer) Infrastructure (Access Point Required) Intel® My Wifi Technology (iPAN)RoamingProvide seamless roaming between like access points (same frequency band)Output Power (for CCK)15 dBmOutput Power (for OFDM; power varies by data rate)15 dBmPower ConsumptionTransmit: 2.3 Watts (average, with one spatial streams) Receive: 1.9 Watts (average with two receive chains) Idle mode: 30mW - 40mW (average) Radio off: 20 mW (max)	Sub-channels	Multinational support with frequency bands and channe	els compliant to local regulations.	
Infrastructure (Access Point Required) intel® My WifT Technology (IPAN)RoamingProvide seamless roaming between like access points (sume frequency band)Output Power (for CCK)15 dBmOutput Power (for OFDM; power varies by data rate)15 dBmPower ConsumptionTransmit: 2.3 Watts (average, with one spatial streams) Receive: 1.9 Watts (average with two receive chains) Idle mode: 30mW - 40mW (average) Radio off: 20 mW (max)Power ManagementCACPI compliant power management 802.11 compliant power saving modeAntenna Connections3 U.FL type connectors, 50 ohm nominal impedanceRange802.11 a - Typical (@6 Mbps)600 feet - Outdoor Open Area 300 feet - Indoor, Office environmentBoz:11 b - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentForm FactorsUSDT: (MIT & SFF: (MIT & SFF:MiniPCI-Express (MIT & SFF:Pomering:0.03 lb (4.0 g)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentJimensions1.1 x 1.2 in (26.8 x 30.0 mm)22° to 176° F (-0° to 80° C) -40° to 176° F (-40° to 80° C) -40° to 176° F (-40° to 80° C)Mumidity0perating: -40° to 176° F (-40° to 80° C) -40° to 176° F (-40° to 80° C) -40° to 176° F (-40° to 80° C)	Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK		
Output Power (for CCK) Output Power (for OFDM; power varies by data rate)15 dBmPower ConsumptionTransmit: 2.3 Watts (average, with one spatial streams) Receive: 1.9 Watts (average with two receive chains) Idle mode: 30mW - 40mW (average) Radio off: 20 mW (max)Power Management 802.11 compliant power saving mode600 feet - 0utdoor Open Area 150 feet - Indoor, Office environment 150 feet - Outdoor Open Area 300 feet - Indoor, Office environmentForm FactorsUSDT: (MIT & SFF: (MIT & SFF	Network Architecture Models	Infrastructure (Access Point Required)		
Output Power (for OFDM; power varies by data rate)15 dBmPower ConsumptionTransmit: 2.3 Watts (average, with one spatial streams) Receive: 1.9 Watts (average with two receive chains) Idle mode: 30mW – 40mW (average) Radio off: 20 mW (max)Power ManagementAcPl compliant power management 802.11 compliant power management 802.11 compliant power management 802.11 compliant power saving modeAntenna Connections3 U.FL type connectors, 50 ohm nominal impedanceRange802.11 a - Typical (@6 Mbps)600 feet - Outdoor Open Area 150 feet - Indoor, Office environment802.11 b - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentForm FactorsUSDT: (MIT & SFF:Veight0.13 lb (4.0 g)Dimensions1.1 x 1.2 in (26.8 x 30.0 mm)Operating: Non-operating: Non-operating:32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C) -40° to 176° F (-40° to 80° C)HumidityOperating: Operating:32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C) -40° to 176° F (-40° to 80° C)	Roaming	Provide seamless roaming between like access points (s	same frequency band)	
power varies by data rate)Power ConsumptionTransmit: 2.3 Watts (average, with one spatial streams)Receive: 1.9 Watts (average with two receive chains)Idle mode: 30mW – 40mW (average)Radio off: 20 mW (max)Power Management802.11 compliant power management802.11 compliant power saving modeAntenna Connections3U.FL type connectors, 50 ohm nominal impedanceRange802.11 b - Typical (@6 Mbps)600 feet - Outdoor Open Area 150 feet - Indoor, Office environment802.11 b - Typical (@1 Mbps)802.11 g - Typical (@1 Mbps)600 feet - Outdoor Open Area 300 feet - Indoor, Office environment1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)802.11 g - Typical (@1 Mbps)803.11 g - Typical (@1 Mbps)804.11 g - Typical (@1 Mbps)805.	Output Power (for CCK)	15 dBm		
Receive: 1.9 Watts (average with two receive chains) Idle mode: 30mW – 40mW (average) Radio off: 20 mW (max)Power Management 802.11 compliant power management 802.11 compliant power saving modeAntenna Connections3 U.FL type connectors, 50 ohm nominal impedanceRange802.11 a - Typical (@6 Mbps)600 feet - 0utdoor Open Area 150 feet - Indoor, Office environment802.11 b - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentForm FactorsUSDT: (MIT & SFF: (MIT & SFF: (MI	-	15 dBm		
Idle mode: 30mW - 40mW (average) Radio off: 20 mW (max)Power Management 802.11 compliant power management 802.11 compliant power saving modeAntenna Connections3 U.FL type connectors, 50 ohm nominal impedanceRange802.11 a - Typical (@6 Mbps)600 feet - 0utdoor Open Area 150 feet - Indoor, Office environmentBo2.11 b - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentBo2.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentForm FactorsUSDT: CMIT & SFF:MiniPCI-Express PCleWeight0.013 lb (4.0 g)PCleOperating Voltage3.3V +/- 9%, 1.5V +/- 5%32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)HumidityOperating:10% to 90% (non-condensing)	Power Consumption	Transmit: 2.3 Watts (average, with one spatial streams)		
Radio off: 20 mW (max)Power ManagementACPI compliant power management 802.11 compliant power saving modeAntenna Connections3 U.FL type connectors, 50 ohm nominal impedanceRange802.11 a - Typical (@6 Mbps)600 feet - Outdoor Open Area 150 feet - Indoor, Office environment802.11 b - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentForm FactorsUSDT: CMIT & SFF:MiniPCI-Express PCleWeight0.013 lb (4.0 g)		Receive: 1.9 Watts (average with two receive chains)		
Power ManagementACPI compliant power management 802.11 compliant power saving modeAntenna Connections3 U.FL type connectors, 50 ohm nominal impedanceRange802.11 a - Typical (@6 Mbps)600 feet - Outdoor Open Area 150 feet - Indoor, Office environment802.11 b - Typical (@1 Mbps)300 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentForm FactorsUSDT:MiniPCI-Express CMIT & SFF:Weight0.013 lb (4.0 g)PCleOperating Voltage3.3V +/-9%, 1.5V +/- 5%TemperatureOperating:32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C) -40° to 176° F (-40° to 80° C)HumidityOperating:10% to 90% (non-condensing)		Idle mode: 30mW – 40mW (average)		
802.11 compliant power saving modeAntenna Connections3 U.FL type connectors, 50 ohm nominal impedanceRange802.11 a - Typical (@6 Mbps)600 feet - Outdoor Open Area 150 feet - Indoor, Office environmentRange802.11 b - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentForm FactorsUSDT: (MIT & SFF:MiniPCI-Express PCIeWeight0.013 lb (4.0 g)PCIeDimensions1.1 x 1.2 in (26.8 x 30.0 mm)32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)Operating Voltage0perating: Non-operating:32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)HumidityOperating:10% to 90% (non-condensing)				
Range802.11 a - Typical (@6 Mbps)600 feet - Outdoor Open Area 150 feet - Indoor, Office environment802.11 b - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)Vertice802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)Nos Fi802.11 g - Typical (@1 Mbps)PoleWeight0.013 lb (4.0 g)Dimensions1.1 x 1.2 in (26.8 x 30.0 mm)Operating Voltage3.3V +/- 9%, 1.5V +/- 5%TemperatureOperating: Non-operating:AumidityOperating: Operating:10% to 90% (non-condensing)	Power Management			
Solution150 feet - Indoor, Office environment802.11 b - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentForm FactorsUSDT:MiniPCI-ExpressCMIT & SFF:PCIeWeight0.013 lb (4.0 g)PCIeDimensions1.1 x 1.2 in (26.8 x 30.0 mm)Operating Voltage3.3V +/-9%, 1.5V +/- 5%TemperatureOperating: Non-operating:32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)HumidityOperating:10% to 90% (non-condensing)	Antenna Connections	3 U.FL type connectors, 50 ohm nominal impedance		
802.11 b - Typical (@ TMbps)300 feet - Indoor, Office environment802.11 g - Typical (@1 Mbps)1200 feet - Outdoor Open Area 300 feet - Indoor, Office environmentForm FactorsUSDT:MiniPCI-ExpressCMIT & SFF:PCleWeight0.013 lb (4.0 g)-Dimensions1.1 x 1.2 in (26.8 x 30.0 mm)-Operating Voltage3.3V +/- 9%, 1.5V +/- 5%32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)HumidityOperating:10% to 90% (non-condensing)	Range	802.11 a - Typical (@6 Mbps)	•	
802.11 g - 1ypicat (@ 1 Mbps)300 feet - Indoor, Office environmentForm FactorsUSDT:MiniPCI-ExpressCMIT & SFF:PCleWeight0.013 lb (4.0 g)		802.11 b - Typical (@1 Mbps)	300 feet - Indoor, Office environment	
CMIT & SFF: PCle Weight 0.013 lb (4.0 g) F Dimensions 1.1 x 1.2 in (26.8 x 30.0 mm) F Operating Voltage 3.3V +/- 9%, 1.5V +/- 5% S Temperature Operating: Non-operating: 32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C) Humidity Operating: 10% to 90% (non-condensing)		802.11 g - Typical (@1 Mbps)	•	
Weight 0.013 lb (4.0 g) Dimensions 1.1 x 1.2 in (26.8 x 30.0 mm) Operating Voltage 3.3V +/- 9%, 1.5V +/- 5% Temperature Operating: Non-operating: 32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C) Humidity Operating: 10% to 90% (non-condensing)	Form Factors	USDT:	•	
Dimensions 1.1 x 1.2 in (26.8 x 30.0 mm) Operating Voltage 3.3V +/- 9%, 1.5V +/- 5% Temperature Operating: Non-operating: 32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C) Humidity Operating: 10% to 90% (non-condensing)				
Operating Voltage 3.3V +/- 9%, 1.5V +/- 5% Temperature Operating: 32° to 176° F (0° to 80° C) Non-operating: -40° to 176° F (-40° to 80° C) Humidity Operating: 10% to 90% (non-condensing)	-	-		
Temperature Operating: 32° to 176° F (0° to 80° C) Non-operating: -40° to 176° F (-40° to 80° C) Humidity Operating: 10% to 90% (non-condensing)				
Non-operating:-40° to 176° F (-40° to 80° C)HumidityOperating:10% to 90% (non-condensing)				
Humidity Operating: 10% to 90% (non-condensing)	Temperature			
	U			
	numiaity		-	



Technical Specifications - Networking and Communications

Microsoft Windows XP

Configuration Utility

- Microsoft Windows XP Wireless Network Connection Manager
- Intel PROSet for Microsoft Windows XP (required for Cisco Compatible Extensions support)

Microsoft Windows Win 7

 Intel IHV extensions for Win7 available to support Cisco Compatible Extensions



Technical Specifications - Audio

High Definition Audio

Туре	Integrated
HD Stereo Codec	Realtek 2-channel ALC221 codec
Audio I/O Ports	Front microphone-In (150-K ohm Input Impedance)
	Rear Line-In/Microphone input (150-K ohm Input Impedance, function is configurable by audio driver)
	Rear Line-Out* (190 ohms Output Impedance, expects at least a 10-K ohm load)
	Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm load) Front Microphone/Headphone jack is re-task able to provide Microphone input, line-in or Headphone output to support connecting two headphones to the front of the system. When configured as a second front headphone output, both front headphone outputs are always driven with the same signal.
	All ports are 3.5mm
Internal Speaker Amplifier	1.5W amplifier for the internal speaker only. External speakers must be powered externally. Rear Line-in audio port is re-taskable as either Line-in or Microphone-In.
Multi-streaming Capable	Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks.
Sampling	8 kHz - 192 kHz
Wavetable Syntheses	Yes – Uses OS soft wavetable
Analog Audio	Yes
# of Channels on Line-Out	Stereo (Left & Right channels)
Internal Speaker	Yes
External Speaker Jack	Yes
Full Duplex	Yes



Technical Specifications - Input/Output Devices

HP USB Keyboard

	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
Physical characteristics	Dimensions (L x W x H)	18.12 x 6.47 x 0.96 in (46.03 x 16.43 x 2.44 cm)	
	Weight	2 lb (0.9 kg)	
	Operating voltage	+ 5VDC ± 5%	
	Power consumption	50-mA maximum (with three LEDs ON)	
Electrical	System interface	USB Type A plug connector	
	ESD	CE level 4, 15-kV air discharge	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft [®] PC 99 - 2001	Functionally compliant	
	Keycaps	Low-profile design	
	Switch actuation	55-g nominal peak force with tactile feedback	
	Switch life	20 million keystrokes (using Hasco modified tester)	
Mechanical	Switch type	Contamination-resistant switch membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	43-dBA maximum sound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)	
	Non-operating temperature	-22° to 140° F (-30° to 60° C)	
	Operating humidity	10% to 90% (non-condensing at ambient)	
	Non-operating humidity	20% to 80% (non-condensing at ambient)	
Environmental	Operating shock	40 g, six surfaces	
	Non-operating shock	80 g, six surfaces	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	4-g peak acceleration	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	30 in (76.2 cm) on concrete, 16-drop sequence	
Approvals	UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC		
Ergonomic compliance	UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, KC		



Technical Specifications - Input/Output Devices

Kit contents	Keyboard	Installation Guide
	Warranty Card	Safety and Comfort Guide

HP PS/2 Keyboard

	Keys	104, 105, 106, 107, 109 layout (depending upon country)
Physical Characteristics	Dimensions (L x W x H)	18.22 x 6.47 x 1.1 in (46.28 x 16.43 x 2.79 cm)
	Weight	2 lb (0.9 kg) minimum
	Operating voltage	+ 5VDC ± 5%
	Power consumption	50-mA maximum (with three LEDs ON)
Electrical	System interface	PS/2 6-pin mini din connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft PC 99 - 2001	Functionally compliant
	Keycaps	Low-profile design
	Switch actuation	55-g nominal peak force with tactile feedback
	Switch life	20 million keystrokes (using Hasco modified tester)
Mechanical	Switch type	Contamination-resistant switch membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	6 ft (1.8 m)
	Microsoft PC 99 - 2001	Mechanically compliant
	Acoustics	50-dBA maximum sound pressure level
	Operating temperature	32° to 104° F (0° to 40° C)
	Non-operating temperature	-22° to 149° F (-30° to 65° C)
	Operating humidity	15% to 80% (non-condensing at ambient)
	Non-operating humidity	15% to 90% (non-condensing at ambient)
	Operating shock	N/A
Environmental	Non-operating shock	65 inch 2.9 ms, six surface; 30g 266 inch/second; 50g 266 inch/second six surface
	Operating vibration	2-g peak acceleration



Technical Specifications - Input/Output Devices

	Non-operating vibration	Starting at 5 Hz, vary the frequency of vibration from 5 to 500 Hz and back to 5 Hz at a Logarithmic sweep rate of 1 octave per minute.
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	29.93 in (76 cm) on concrete, 16-drop sequence
Approvals	CUL, ICES-003 Class B, FCC, CE N	Mark,TUV GS, VCCI, BSMI, C-Tick, KC
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS	

HP USB Smart Card (CCID) Keyboard

	CID/ ACYDOUIU		
Key Benefits:	 Protects against unauthorized access with smart card technology Delivers even greater security when combined with a HP Client Security smart card and the HPC Client Security Software Combination of username and password or pin with a smart card or security token Secures online transactions using digital signatures and certificates Conforms to industry standards for ease of setup and use Delivers long product life and quiet operation with high-impact materials and lubricated keys Spill drain feature 		
Physical Characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country	
	Form factor	USB basic smart card keyboard	
	Colors	Carbonite/Silver	
	Dimensions (H x W x D)	18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)	
	Weight	2 lb (0.9 kg) minimum	
Electrical	Operating voltage	+ 5VDC ± 5%	
	Power consumption	100-mA maximum (with four LEDs ON)	
	System interface	USB Type A plug connector	
	ESD	CE level 4, 15-kV air discharge	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft PC 99 - 2001	Functionally compliant	
Mechanical	Languages	30+ available	
	Keycaps	Standard design	
	Switch actuation	55 g nominal peak force with tactile feedback	
	Switch life	20 million keystrokes (using Hasco modified tester)	
	Switch type	Contamination-resistant membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
Environmental	Acoustics	43-dBA maximum sound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)	



Technical Specifications - Input/Output Devices

	Non-operating temperature Operating humidity	-22° to 140° F (-30° to 60° C) 10% to 90% (non-condensing a	t amhient)
	Non-operating humidity	20% to 80% (non-condensing a	
	Operating shock	40 g, six surfaces	
	Non-operating shock	80 g, six surfaces	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	4-g peak acceleration	
	Drop	26 in (66 cm) on carpet, six-dro	p sequence
	(out of box)	•	
	Drop (in box)	42 in (107 cm) on concrete, 16-	drop sequence
SmartCard Function	Support	All ISO 7816 smart cards	
	Interface	Reads from and writes to all ISC microprocessor smart cards (T=	
	Chipset	SCM STCIII	
	Standard APIs supported	PC/SC, EMV2000, CT-API	
	Power	USB Port	
		Short circuit detection (protects	s smart card and reader)
		Power supply compliant with IS	07816 and EMV (5V, 60 mA)
		Supports 3-V and 5-V cards	
	Power consumption	100-mA maximum draw	
	Communication	From card	9600 bps to 330,000 bps
		From computer	12 Mbps (USB transfer speed)
	Landing mechanism	Contact device	Friction contact
		Card insertions rating	Up to 100,000 insertion cycles
	Interface modes	CCID protocol	
	Reader performance interface	USB connection	
	Electro-magnetic standards	Europe	2004/108/EC
A			USAFCC part 15
Approvals	CE-Mark, UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, EMV2000, USB-IF		
Ergonomic Compliance	ISO 9241-4, TUVGS		
Kit Contents	Keyboard, I/O Security and Documentation CD, warranty card		

HP USB PS/2 Washable Keyboard

	Keys	104 (US) layout or 105 (EU) layout – depending upon country
Physical Characteristics	Dimensions (L x W x H)	17.67x 6.62 x 1.38 in (449 x 168 x 35 mm)
	Weight	1.7 lb (0.77 kg) minimum
	Operating voltage	+ 5VDC ±5%



Technical Specifications - Input/Output Devices

	Power consumption	50-mA maximum (with three LEDs ON)			
Electrical	System interface	USB Type A plug connector			
	ESD	CE level 4, 15-kV air discharge			
	EMI - RFI	Conforms to FCC rules for a Class B computing device			
	Microsoft [®] PC 99 - 2001	Functionally compliant			
	Кеусарѕ	Stepped -profile design			
	Switch actuation	55-g nominal peak force with tactile feedback			
	Switch life	20 million keystrokes			
Mechanical	Switch type	Contamination-resistant switch membrane			
	Key-leveling mechanisms	For all double-wide and greater-length keys			
	Cable length	7 ft (2.2 m)			
	Microsoft PC 99 - 2001	Mechanically compliant			
	Acoustics	43-dBA maximum sound pressure level			
	Operating temperature	50° to 122° F (10° to 50° C)			
	Non-operating temperature	-22° to 140° F (-30° to 60° C)			
	Operating humidity	10% to 95% (non-condensing at ambient)			
	Non-operating humidity	0% to 95% (non-condensing at ambient)			
Environmental	Operating shock	40 g, six surfaces			
	Non-operating shock	80 g, six surfaces			
	Operating vibration	2-g peak acceleration			
	Non-operating vibration	4-g peak acceleration			
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence			
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence			
Operating system support	Windows® 7, Windows Vista, Windows XP Professional				
Approvals	UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1, IP66/NEMA4X				
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS				

HP Wireless Keyboard and Mouse

	Dimensions (H x L x W)	1.09 x 18.1 x 6.47 in (27.87 x 460.3 x 164.3 mm)
Keyboard	Weight – Without Two AA Alkaline Batteries	1.94 lb (880 g)



Technical Specifications - Input/Output Devices

	Dimensions (H x L x W)	1.46 x 4.53 x 2.47 in (37 x 115 x 62.9 mm)		
Mouse	Weight – Without Two AA Alkaline Batteries	0.15 lb (67 g)		
	Dimensions (H x L x W)	0.33 x 1.79 x 0.72 in (8.4 x 45.5 x 18.4 mm)		
Receiver	Weight	0.21 oz (5.9 g)		
KELEIVEI	Cable Length – Minimum	6 ft (1.8 m)		
	Range	32.8 ft (10 m)		
System Requirements	Windows 7 Home Basic*, Windows 7 Home Premium*, Windows 7 Professional Edition 32*, Windows 7 Professional Edition 64*, Windows 7 Ultimate Edition 32*, Windows 7 Ultimate Edition 64* Windows Vista or Windows XP Available USB port for the receiver CD-ROM Drive *This system may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See			
	http://www.microsoft.com/win			
	Product Safety	UL; CSA /TUV (Europe only); CE Mark; CB Report		
	Ergonomics	ANSI; ISO (Europe only); GS Mark (Germany only)		
	EMC	FCC; CE; ACA (-tick); BSMI; KC ; VCCI		
	CE Mark	EN 55022:2010; EN 55024; EN 301489-1; EN 61000		
	Design Guidelines for PCs	PC 99 - connector overmold colors; PC 2001 - full functionality		
	Telecom	All local telecom requirements and approvals for intended markets		
Approvals	USA	FCC Title 47 CFR, Par 15, Subpart C; other local requirements		
	Country Support	US, Belgium, Switzerland, Spain, Denmark, Netherlands, France, Germany, Italy, Portugal, Sweden, Norway, Finland, UK, Poland, Czech Republic, Turkey, Greece, Austria, Bulgaria, Cyprus, Estonia, Hungary, Ireland, Latvia, Lithuania, Luxemburg, Malta, Romania, Slovakia, Slovenia, Vietnam, HK, Australia, NZ, Malaysia, Singapore, Indonesia, Philippines, Thailand, Canada, China, Japan, Korea, Taiwan, India, Venezuela, Ecuador, Russia, Ukraine, Israel, Croatia, United Arab Emirates, Peru, Brazil, Chile, Argentina, Mexico, South Africa, and up to 193 countries worldwide.		
Environmental	Keyboard contains 25% post-co	onsumer recycled plastic material		

HP PS/2 Mouse

Dimensions (H x L x W)

1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)



Technical Specifications - Input/Output Devices

Weight	3.53 oz (100g; +10g/- 5 g)			
	Operating temperature	-32° to 104°F (0° to 40° C)		
	Non-operating temperature	-4° to 140°F (-20° to 60° C)		
	Operating humidity	10% to 90% (non condensing at ambient)		
	Non-operating humidity	10% to 90% (non condensing at ambient)		
Environmental	Operating shock	40 g, 6 surfaces		
	Non-operating shock	80 g, 6 surfaces		
	Operating vibration	2 g peak acceleration		
	Non-operating vibration	4 g peak acceleration		
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face		
	Operating voltage	5 VDC ± 10%		
	Power consumption	100mA		
Electrical	System consumption	PS/2 mini-din connector		
	ESD	CE level 4, 15 kV air discharge		
	EMI-RFI	Conforms to FCC rules for a Class B computing device		
	Microsoft PC99 - 2001	Functionally compliant		
	Resolution	800 DPI		
	Tracking speed	10 in/s (25.4 cm/s) maximum		
	Acceleration	±15%		
	Switch actuation	65±20 gf		
Mechanical	Switch life	3,000,000 operations (using Hasco modified tester)		
	Switch type	Low force micro-switches		
	Tracking mechanism life	80 km		
	Cable length	6 ft (1.8 m)		
	Microsoft PC99 - 2001	Mechanically compliant		
	Width	6 mm		
	Diameter	22.5 ± 0.2 mm		
Scroll wheel	Maximum rotation force	50 gf-cm		
	Switch type	Light force micro-switch		



Technical Specifications - Input/Output Devices

	Switch life	1 million operations	
	Mechanical life	Minimum 200,000 revolutions	
Regulatory Approvals	UL/cUL, FCC, CE Mark, TUV/GS, VCCI, KCC, BSMI, C-Tick		

HP USB Mouse

Dimensions (H × L × W)	1.5 x 4.5 x 2.5 in (3.8 x 11.6 x 6.3 cm)
Weight	0.22 lb (0.10 kg)
Cable length	70.9 in (180 cm)
System requirements	Available USB port

HP USB 1000dpi Laser Mouse

Dimensions (H x L x W)	1.47 x 4.53 x 2.47 in (37.3 x 114.97 x 62.86 mm)		
Weight	3.360 oz (102g)		
Cable length	70.9 in (180 cm)		
System requirements	Available USB port		
	Operating Temperature	32° to 104° F (0° to 40° C)	
Environmental	Non-operating Temperature	-4° to 140° F (-20° to 60° C)	
	Operating Humidity	10% to 90% (non-condensing at ambient)	
	Resolution	1000dpi	
Mechanical	Tracking Speed	45 cm/sec	
	Cable Length	70.9 in (180 cm)	



Technical Specifications - Input/Output Devices

HP USB PS/2 Washable Mouse

Dimensions (H x L x W) 1.56 x 2.44 x 4.61 in (3.95 x 6.21 x 11.7 cm)

	Weight	4.44 oz (126 g)	
		Operating temperature	–32° to 104°F (0° to 40° C)
		Non-operating temperature	–4° to 140°F (–20° to 60° C)
		Operating humidity	10% to 90% (non-condensing at ambient)
		Non-operating humidity	10% to 90% non-condensing
	Environmental	Operating shock	40 g, 6 surfaces
		Non-operating shock	80 g, 6 surfaces
		Operating vibration	2 g peak acceleration
		Non-operating vibration	4 g peak acceleration
		Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face
		Operating voltage	5 VDC ± 10%
		Power consumption	100mA
	Electrical	System consumption	PS/2 mini-din connector or USB
		ESD	CE level 2 8 kV air discharge
		EMI-RFI	Conforms to FCC rules for a Class B computing device
		Microsoft® PC99 – 2001	Functionally compliant
		Resolution	1000 ± 20% DPI
		Tracking speed	14 in/s (35.56 cm/s) maximum
		Acceleration	2 g
	Mechanical	Switch actuation	70 g nominal peak force
		Switch life	3,000,000 operations (using Hasco modified tester)
		Switch type	Low force micro-switches
		Cable length	8.8 ft total 70 cm+ 2m extension
		Microsoft PC99 – 2001	Mechanically compliant
		Width	6 mm
		Diameter	1 in (25.4 mm)
	Scroll wheel	Maximum rotation speed	48 rats/sec
		Switch type	Light force micro-switch
		Switch life	3 million operations
		Mechanical life	Minimum 200,000 revolutions
	Regulatory approvals	Compliant	FCC, CE Mark, ICES-003-B, IP66/NEMA4X



Technical Specifications – Power

Unit Environment and Operating Conditions

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's recirculated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range	Operating: 50° to 95° F (10° to 35° C)* Non-operating: –22° to 140° F(–30° to 60° C)
Relative Humidity	Operating: 10% to 90% (non-condensing at ambient) Non-operating: 5% to 95% (non-condensing at ambient)
Maximum Altitude (unpressurized)	Operating: 10,000 ft (3048 m) Non-operating: 30,000 ft (9144 m)

*Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply	DM	U	SDT	SFF	TWR
Standard Efficiency	65W active PFC 87% efficient	Integrated graphics:	135W active PFC 87% efficient	240W active PFC	320W active PFC
		Discrete graphics:	180W active PFC 87% efficient		
High Efficiency* 80 PLUS Gold	N/A	N/A		240W active PFC	320W active PFC
				87/90/87% efficient at 20/50/100% load (115V)	87/90/87% efficient at 20/50/100% load (115V)
				89/91/90% efficient at 20/50/100% load (230V)	89/92/90% efficient at 20/50/100% load (230V)
High Efficiency* 80 PLUS Platinum	N/A			240W active PFC	320W active PFC
				90/92/89% efficient at 20/50/100% load (115V)	90/92/89% efficient at 20/50/100% load (115V)
				90/93/91% efficient at 20/50/100% load (230V)	90/94/91% efficient at 20/50/100% load (230V)
Operating Voltage Range	90 - 264 VAC	90 - 264 VA	-	90 - 264 VAC	90 - 264 VAC
Rated Voltage Range	100 - 240 VAC	100 - 240 V	AC	100 - 240 VAC	100 - 240 VAC
Rated Line Frequency	50/60 Hz	50/60 Hz		50/60 Hz	50/60 Hz



Technical Specifications – Power					
Operating Line Frequency	/ 47 - 63 Hz	47 - 63 Hz	47 - 63 Hz	47 - 63 Hz	
Rated Input Current	N/A	N/A	4A	5.5A	
Rated Input Current with Energy Efficient* Power Supply		135W: 2.4A 180W: 2.9A	4A	5.5A	
DC Output	+19.5V	N/A	N/A	N/A	
Current Leakage (NFPA 99)	< 250 µA	< 250 µA	< 275 μA	<450=>275uA	
Power Supply Fan	N/A	N/A	92=>70mm variable speed	92mm variable speed	
Power cord length	N/A	N/A	6.0 ft. (1.83 m)	6.0 ft. (1.83 m)	
External Power Adapter					
Dimensions	2.2 x 1.2 x 4.5 in 55 x 30 x 113.5 mm	2.8 x 1.7 x 6.6 in 70 x 42 x 167.5 mm	N/A	N/A	
Total Cord Length	12 ft 8 in	12 ft 8 in	N/A	N/A	

*High efficiency power supply is a requirement for ENERGY STAR[®] qualification in conjunction with a select range of processors and modules



Technical Specifications – Weights & Dimensions

Weights & Dimensions (configured with 1 HDD & 1 ODD)

-	DM	USDT	SFF	TWR
Chassis (W x H x D)	6.9 x 1.3 x 7.0 in	9.9 x 2.6 x 10 in	13.3 x 3.95 x 14.9 in	6.7 x 15.7 x 17.4 in
	175 x 34 x 177 mm	251 x 66 x 254 mm	338 x 100 x 379 mm	170 x 399 x 442 mm
System Volume	62.79 cu in	257.5 cu in	782.7 cu in	1828 cu in
	1.05 L	4.2 L	12.8 L	30 L
System Weight*	2.9 lb	6.8 lb	16.7 lb	20.5 lb
	1.3 kg	3.1 kg	7.6 kg	9.3 kg
Max Supported Weight (desktop orientation)	N/A	77.0 lb 35.0 kg	77.0 lb 35.0 kg	N/A
Stand Dimensions	.77x 4.6 x 6.3 in 19.5 x 117 x 160 mm Weight: 47g/ .1 lbs.	1.1 x 4.9 x 6.7 in 27 x 125 x 170 mm	1.1 x 7.0 x 7.9 in 29 x 178 x 200 mm	N/A
Packaging (H x W x D)	7.8 x 11.4 x 19.7 in	8.6 x 15.7 x 19.7 in	9.0 x 19.7 x 23.4 in	11.6 x 19.7 x 23.2 in
	198 x 290 x 500 mm	218 x 398 x 500 mm	229 x 500 x 594 mm	295 x 500 x 590 mm
Shipping Weight	9.0 lb.	14.4 lb	17.9 lb	28.8 lb
	4.1 kg	6.5 kg	8.1 kg	13.1 kg
Palletization Profile	8-units per layer 10/12 layer max 80/96 per pallet (Dependent on 40-Ft	6-units per layer 10-layer max. 60-units per pallet	4-units per layer 10-layer max. 40-units per pallet	4-units per layer 8-layer max. 32-units per pallet
	Stnd. Sea Container or 40- Ft High-cube Sea Container is used)			



Technical Specifications – Miscellaneous Features

Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel Wired for Management support; industry wide initiative to make Intel architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
 - Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
 - 2 processor thermal protection activated
 - 3 processor not installed
 - 4 power supply failure
 - 5 -- memory error
 - 6 video error
 - 7 PCA failure (ROM detected failure prior to video)
 - 8 invalid ROM, bootblock recovery mode
 - 9 system not fetching code
 - 10 system hang while loading an option ROM
- HP PC Hardware Diagnostics UEFI:
 - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification



Technical Specifications – Miscellaneous Features

Additional Features	Description
Towerable Orientation	Product can be oriented as either a desktop or a tower
Drive Lock	Implementation of the industry standard ATA Security feature set. When enabled, it prevents software access to user data on the drive until one or two user-defined passwords are provided.
	DPS Access through F10 Setup during Boot
	A diagnostic hard drive self test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user
Drive Protection System	Running independently of the operating system, it can be accessed through a Windows- based diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced
	The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures
SMART Technology (Self-Monitoring, Analysis and Reporting Technology)	Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted
SMART I - Drive Failure Prediction	Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry count
SMART II - Off-Line Data Collection	By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure
SMART III - Off-Line Read Scanning with	IOEDC: I/O Error Detection Circuitry
Defect Reallocation	Detects errors in Read/Write buffers on HDD cache RAM

SMART IV - End-to-End CRC for hard drives Interface in F10 setup provides confirmation of SMART IV support.



Environmental Data

Eco-Label Certifications & Declarations System Configuration	 This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: IT ECO declaration US ENERGY STAR® EPEAT Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country. *NOTE: This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System. The configuration used for the Energy Consumption and Declared Noise Emissions data is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system. 			
Model	Energy Consumption (typically configured)	115 VAC	230VAC	100VAC
DM	Normal Operation	8.0867 W	8.1820 W	8.1207 W
	Sleep (ENERGY STAR [®] low power mode)	1.6165 W	1.5780 W	1.6442 W
	Off	1.0216 W	1.0115 W	1.0437 W
USDT	Normal Operation	15.16 W	15.72 W	15.08 W
	Sleep (ENERGY STAR® low power mode)	0.98 W	1.01 W	0.97 W
	Off	0.80 W	0.83 W	0.80 W
SFF	Normal Operation	22.90 W	22.78 W	23.08 W
	Sleep (ENERGY STAR® low power mode)	1.64 W	1.73 W	1.64 W
	Off	0.70 W	0.77 W	0.70 W
TOWER	Normal Operation	25.74 W	28.27 W	26.01 W
	Sleep (ENERGY STAR® low power mode)	1.66 W	1.76 W	1.65 W
	Off	0.68 W	0.78 W	0.67 W

NOTE: Energy efficiency data listed is for an ENERGY STAR[®] compliant product if offered within the model family. HP computers marked with the ENERGY STAR[®] Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR[®] specifications for computers. If a model family does not offer ENERGY STAR[®] compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows[®] operating system.

Model	Heat Dissipation*	115 VAC	230VAC	100VAC



Technical Specifications – Environmental Data

DM	Normal Operation	26 BTU/hr	26 BTU/hr	26 BTU/hr
	Sleep	5 BTU/hr	5 BTU/hr	5 BTU/hr
	Off	3 BTU/hr	3 BTU/hr	3 BTU/hr
USDT	Normal Operation	52 BTU/hr	54 BTU/hr	64 BTU/hr
	Sleep	3 BTU/hr	3 BTU/hr	3 BTU/hr
	Off	3 BTU/hr	3 BTU/hr	3 BTU/hr
SFF	Normal Operation	78 BTU/hr	78 BTU/hr	79 BTU/hr
	Sleep	6 BTU/hr	6 BTU/hr	6 BTU/hr
	Off	2 BTU/hr	3 BTU/hr	2 BTU/hr
TOWER	Normal Operation	88 BTU/hr	97 BTU/hr	89 BTU/hr
	Sleep	6 BTU/hr	6 BTU/hr	6 BTU/hr
	Off	2 BTU/hr	3 BTU/hr	2 BTU/hr

>***NOTE:** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
Model	(Typically configured)		
DM	Idle	3.6	25
	Fixed Disk (random writes)	3.6	25
USDT	Idle	3.6	27
	Fixed Disk (random writes)	3.6	27
SFF	Idle	3.6	26
	Fixed Disk (random writes)	3.6	26
Tower	Idle	3.6	25
	Fixed Disk (random writes)	3.6	26

Longevity and UpgradingThis product can be upgraded, possibly extending its useful life by several years.BatteriesThis battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the 1ppm by weight
- Cadmium greater than 20ppm by weight

Battery Size CR2032 (coin cell)



	Battery Type Lithium
Model	Additional Information
DM	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.
	 This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
	 This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
	 This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.
	 Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
	 This product contains 16% post consumer recycled plastic (by wt.) This product is 91.3% recyclable when properly disposed of at end of life.
	ALL Form Factors are UL Certified
USDT	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
	 This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
	 This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
	 This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
	 Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
	 This product contains 12.2 % post-consumer recycled plastic (by wt.) This product is 95.4 % recycle-able when properly disposed of at end of life.
	ALL Form Factors are UL Certified
	Packaging Materials
	 External: PAPER/Corrugated 1526.2 g
	 LASTIC/Polyethylene low density 177 g
	• The PAPER/Corrugated material contains at least 49.42% recycled content.
	 The PLASTIC/Polyethylene low density material contains at least 60.42% recycled content.
SFF	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
	 This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
	 This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
	 This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
	 Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
	 This product contains 14.8 % post-consumer recycled plastic (by wt.) This product is 94.1 % recycle-able when properly disposed of at end of life
	• This product is $W(1) \ll recursionable when properly disposed of at end of life$

• This product is 94.1 % recycle-able when properly disposed of at end of life.



Packaging Materials

- External:
 - PAPER/Corrugated 2300 g
- Internal:
 - PLASTIC/Polyethylene low density 56 g
 - O PLASTIC/EPE-Expanded Polyethylene 110 g
 - PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated material contains at least 38.38% recycled content.
- The PLASTIC/Polyethylene low density material contains at least 60.42% recycled content.
- The PLASTIC/EPE-Expanded Polyethylene material contains at least 60.42% recycled content.
- The PLASTIC/Polyethylene material contains at least 60.42% recycled content
- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 15 % post-consumer recycled plastic (by wt.)
- This product is 95.5 % recycle-able when properly disposed of at end of life.

Packaging Materials

- External:
 - PAPER/Corrugated 2280 g
- Internal:
 - PLASTIC/Polyethylene low density 40 g
 - O PLASTIC/EPE-Expanded Polyethylene 144 g
 - O PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated packaging material contains at least 53.5 % recycled content.
- The PLASTIC/Polyethylene low density packaging material contains at least 60.42 % recycled content
- The PLASTIC/EPE-Expanded Polyethylene packaging material contains at least 60.42 % recycled content.
- The PLASTIC/Polypropylene packaging material contains at least 60.42 % recycled content.

Common to all Form Factors

RoHS Compliance	Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. By July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).
Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at



Tower

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):
	Asbestos
	Certain Azo Colorants
	 Certain R20 colorants Certain Brominated Flame Retardants - may not be used as flame retardants in plastics
	Cadmium
	 Chlorinated Hydrocarbons Chlorinated Paraffins
	Formaldehyde
	Halogenated Diphenyl Methanes
	Lead carbonates and sulfates
	 Lead and Lead compounds
	Mercuric Oxide Batteries
	 Nickel - finishes must not be used on the external surface designed to be frequently handled
	or carried by the user.
	Ozone Depleting Substances
	 Polybrominated Biphenyls (PBBs)
	 Polybrominated Biphenyl Ethers (PBBEs)
	 Polybrominated Biphenyl Oxides (PBBOs)
	 Polychlorinated Biphenyl (PCB)
	 Polychlorinated Terphenyls (PCT)
	 Polyvinyl Chloride (PVC) - except for wires and cables, and certain retail packaging has been
	voluntarily removed from most applications.
	Radioactive Substances
	 Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:
Packaying Usage	The follows these guidelines to decrease the environmental impact of product packaging.
	 Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in
	packaging materials.
	 Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
	 Design packaging materials for ease of disassembly.
	 Maximize the use of post-consumer recycled content materials in packaging materials.
	 Use readily recyclable packaging materials such as paper and corrugated materials.
	 Reduce size and weight of packages to improve transportation fuel efficiency.
	 Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic
•	areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your
Recycling	nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a
	responsible manner.
	responsible manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for
	each product type for use by treatment facilities. This information (product disassembly
	instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These
	instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM
	customers who integrate and re-sell HP equipment.
Hardett Baskand Company	
Hewlett-Packard Corporate	For more information about HP's commitment to the environment:
Environmental Information	Clabal Citizanakia Depart
	Global Citizenship Report
	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Eco-label certifications
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:



http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/ PC_GBU_Product_Design_ISO_14K_Certificate.pdf and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



After-Market Options (availability may vary by region)

Communication Devices	DM	USDT	SFF/TWR	Part Number
Intel Ethernet I210 - T1 Gbe NIC			х	E0X95AA
Intel 6205 802.11 a/b/g/n PCIe x1 NIC			Х	E0X93AA
Graphics Solutions	DM	USDT	SFF/TWR	Part Number
AMD Radeon HD 8350 Graphics (PCIe x16)			х	E1C63AA
AMD Radeon HD 8490 Graphics Card			х	E1C64AA
Nvidia NVS 310 Graphics (PCIe x16)			х	A7U59AA
Nvidia NVS 315 Graphics (PCIe x16)			х	E1C65AA
HP USB Graphic Adapter		х	х	NL571AA
HP DisplayPort Cable Kit	Х	х	х	VN567AA
HP DisplayPort To Dual Link DVI-D Adapter	Х	х	х	NR078AA
HP DisplayPort To DVI-D Adapter	Х	х	х	FH973AA
HP DisplayPort to HDMI Adapter	Х	х	х	BP937AA
HP DisplayPort to VGA Adapter	Х	х	х	AS615AA
HP DMS-59 to Dual DVI Cable			х	DL139A
HP DMS-59 to Dual DisplayPort Adapter			Х	XP688AA
Data Storage Drives and Accessories	DM	USDT	SFF/TWR	Part Number
HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive			х	QK554AA
HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive			х	QK555AA
HP 1-TB 10K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive			х	C2T91AA
HP 128-GB SATA 3.0Gb/s Solid State Drive	Х	х	х	QV063AA
HP 160-GB SATA 3.0Gb/s Solid State Drive	Х	х	х	QV064AA*
HP 500-GB SATA 3.0Gb/s Solid State Hybrid Drive	Х	х	х	E1C62AA
HP 128-GB SED Opal 2 Solid State Drive	Х			G1K24AA
HP Slim Removable SATA Hard Drive Enclosure (frame & carrier)		х	х	C1N41AA
HP Slim Removable SATA Hard Drive Enclosure (carrier only)		х	х	E3F39AA
HP Chassis (1bay) Security Kit			TWR only	AR639AA
*Not available in all regions.				



After-Market Options (availability may vary by region)

Input Devices	DM	USDT	SFF/TWR	Part Number
HP USB Keyboard	х	х	х	QY776AA
HP USB Gray Keyboard	Х	х	х	B6B64AA
HP USB Smart Card (CCID) Keyboard	х	х	х	BV813AA
HP USB Keyboard and Mouse Kit	Х	х	х	B1T09AA
HP USB Washable Keyboard	Х	х	х	VF097AA
HP USB and PS/2 Washable Mouse	Х	х	Х	BM866AA
HP USB and PS/2 Washable Keyboard and Mouse Kit	Х	х	х	BU207AA
HP PS/2 Mouse	Х	х	Х	QY775AA
HP USB Mouse	х	Х	Х	QY777AA
HP USB 1000dpi Laser Mouse	х	Х	Х	QY778AA
HP Wireless Keyboard and Mouse Combination*	Х	Х	Х	QY449AA
*Keyboard contains 25% post-consumer recycled plastic mat	erial			
System Memory	DM	USDT	SFF/TWR	Part Number
HP 4GB DDR3-1600 (PC3-12800) DIMM			х	B4U36AA
HP 8GB DDR3-1600 (PC3-12800) DIMM			х	B4U37AA
HP 4GB DDR3-1600 (PC3-12800) SODIMM	Х	х		B4U39AA
HP 8GB DDR3-1600 (PC3-12800) SODIMM	Х	Х		B4U40AA
Multimedia Devices	DM	USDT	SFF/TWR	Part Number
HP Slim DVD-ROM Drive		х	х	VP033AA
HP Slim SuperMulti DVD Writer Drive		х	х	QS209AA
HP USB HD 720P v2 Business Webcam	Х	х	х	D8Z08AA
HP Business Headset	х	х	х	QK550AA
HP USB Business Speakers	х	х	х	D9J19AA
Removable Media Storage	DM	USDT	SFF/TWR	Part Number
HP 14-n-1 Media Card Reader			х	TBD
Security Devices	DM	USDT	SFF/TWR	Part Number
HP USDT Rear Port Controller Cover		Х		VN571AA
HP Solenoid Lock and Hood Sensor (USDT/SFF)		х	х	E0X97AA
HP Solenoid Lock and Hood Sensor (TWR)			TWR only	E0X96AA
HP SFF Wall Mount/Security Sleeve			SFF only	VN570AA
HP UltraSlim Cable Lock	Х	х	x	H4D73AA



After-Market Options (availability may vary by region)

Stands and Accessories	DM	USDT	SFF/TWR	Part Number
HP Integrated Work Center - Desktop Mini / Thin Client (IWCdm)	Х			G1V61AA
HP Integrated Work Center Stand (SFF)			SFF only	QP897AA
HP Integrated Work Center Stand (USDT)		х		LH526AA
HP USDT Tower Stand		х		VN568AA
HP SFF Tower Stand			SFF only	VN569AA
HP DM Chassis Tower Stand	Х			G1K23AA
HP 600/800 Tower Bezel Kit			TWR only	E1C66AA
HP 800/600 SFF Bezel Kit			SFF only	E3F27AA
HP 800 USDT Kit		х		E3F28AA
HP Serial Port Adapter (RS-232 compatible)			х	PA716A
HP Parallel Port Kit			х	KD061AA
HP PCI Expansion Kit			TWR only	E1V16AA
Belkin USB to Serial Adapter	Х	Х		EM449AA

LANDesk Software (E-Delivery)	Part Number
LANDesk Management Suite License - 1-499 Nodes E-Delivery	QY369AAE
LANDesk Management Suite License - 500-999 Nodes E-Delivery	QY370AAE
LANDesk Management Suite License - 1000-1999 Nodes E-Delivery	QY371AAE
LANDesk Management Suite License - 2000-4999 Nodes E-Delivery	QY372AAE
LANDesk Management Suite License - 5000-9999 Nodes E-Delivery	QY373AAE
LANDesk Security Suite License E-Delivery	QY379AAE
LANDesk Management Suite 1 Year Maintenance - 1-499 Nodes E-Delivery	HZ825AAE
LANDesk Management Suite 1 Year Maintenance - 500-999 Nodes E-Delivery	HZ826AAE
LANDesk Management Suite 1 Year Maintenance - 1000-1999 Nodes E-Delivery	HZ827AAE
LANDesk Management Suite 1 Year Maintenance - 2000-4999 Nodes E-Delivery	HZ828AAE
LANDesk Management Suite 1 Year Maintenance - 5000-9999 Nodes E-Delivery	HZ829AAE
LANDesk Security Suite 1 Year Subscription	HZ830AAE
LANDesk Patch Management 1 Year Subscription - 1-499 Nodes E-Delivery	HZ831AAE
LANDesk Patch Management 1 Year Subscription - 500-999 Nodes E-Delivery	HZ832AAE
LANDesk Patch Management 1 Year Subscription - 1000-1999 Nodes E-Delivery	HZ833AAE
LANDesk Patch Management 1 Year Subscription - 2000-4999 Nodes E-Delivery	HZ834AAE
LANDesk Patch Management 1 Year Subscription - 5000-9999 Nodes E-Delivery	HZ835AAE



After-Market Options (availability may vary by region)

© Copyright 2014 Hewlett-Packard Development Company, L.P. All rights reserved.

The information contained herein is subject to change without notice and is provided "as is" without warranty of any kind. The warranties for HP products are set forth in the express limited warranty statements accompanying such products. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein. Microsoft, Windows and Windows 7 are registered trademarks or trademarks of Microsoft Corporation in the U.S. and/or other countries. Intel and Core are registered trademarks or trademarks of Intel Corporation in the U.S. and/or other countries. Bluetooth is a registered trademark of Bluetooth SIG, Inc., in the U.S. and other countries. All other product names mentioned herein may be trademarks of their respective companies.

